

# Compal Confidential

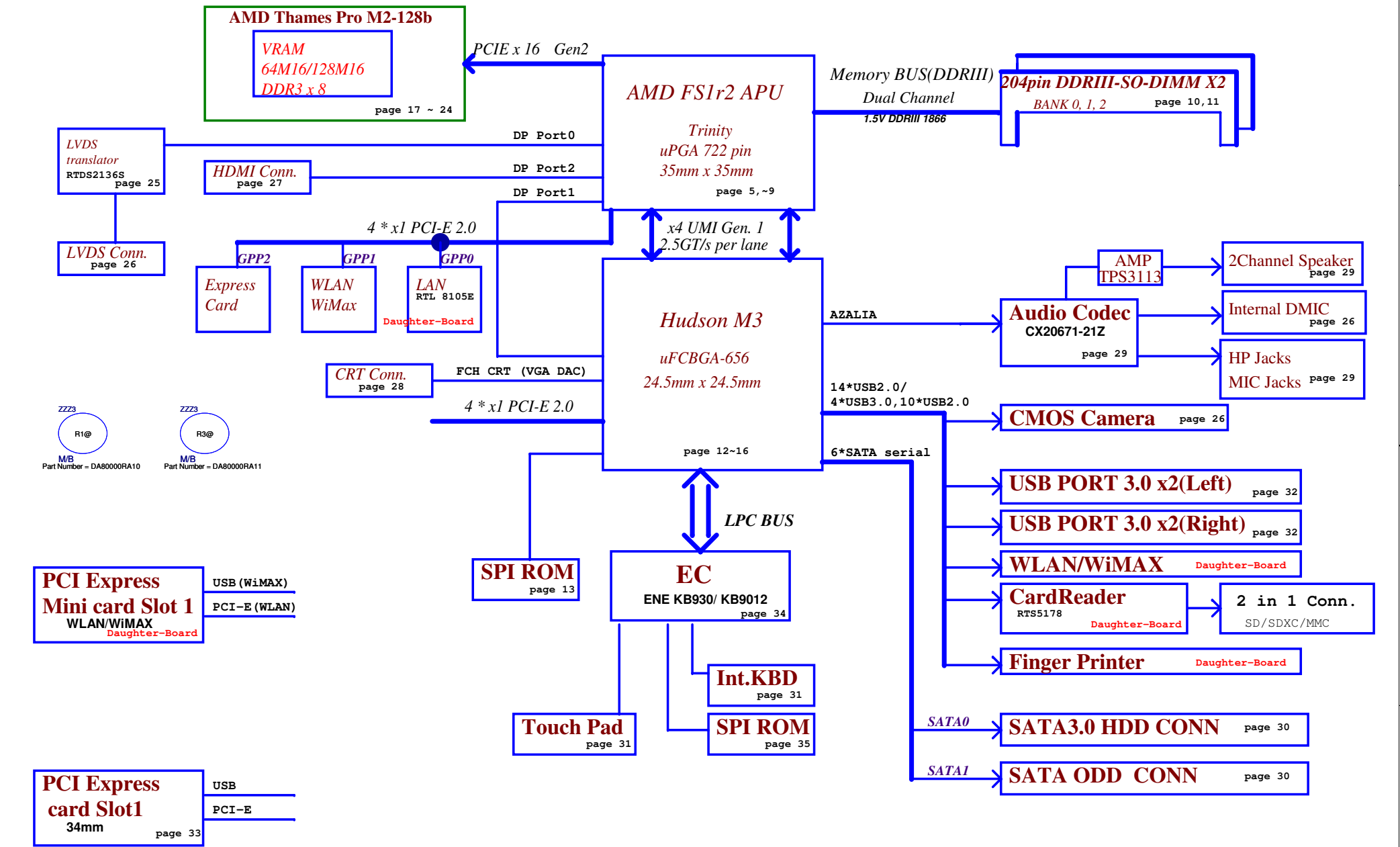
## QCL10 Schematics Document

AMD APU Trinity FS1r2 + FCH Hudson-M3 + GPU Seymour/Thames XT

2012-07-13

REV:1.0 (A00)

Security Classification	Compal Secret Data			Compal Electronics, Inc.	
Issued Date	2011/08/01	Deciphered Date	2013/01/01	Title	Cover Page
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF FIRST DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Document Number	LA8251P
				Date	Monday, July 16, 2012
				Sheet	1 of 50
				Rev	1.0



Voltage Rails

Power Plane	Description	S1	S3	S5
VIN	Adapter power supply (19V)	N/A	N/A	N/A
B+	AC or battery power rail for power circuit.	N/A	N/A	N/A
+APU_CORE	Core voltage for APU	ON	OFF	OFF
+APU_CORE_NB	Voltage for On-die VGA of APU	ON	OFF	OFF
+1.5V	1.5V power rail for APU VDDIO and DDR	ON	ON	OFF
+0.75VS	0.75V switched power rail for DDR terminator	ON	OFF	OFF
+1.2VS	1.2V (VDDR, VDDP) switched power rail for APU	ON	OFF	OFF
+2.5VS	2.5V for APU VDDA	ON	OFF	OFF
+1.1VALW	1.1V switched power rail for FCH	ON	ON	ON*
+1.1VS	1.1V switched power rail for FCH	ON	OFF	OFF
+1.5VS	1.5V switched power rail	ON	OFF	OFF
+VGA_CORE	0.95-1.2V switched power rail	ON	OFF	OFF
+1.5VGS	1.5V switched power rail	ON	OFF	OFF
+1.8VGS	1.8V switched power rail	ON	OFF	OFF
+1.0VGS	1.0V switched power rail for VGA	ON	OFF	OFF
+3VALW	3.3V always on power rail	ON	ON	ON*
+3V_LAN	3.3V power rail for LAN	ON	ON	ON*
+3VS	3.3V switched power rail	ON	OFF	OFF
+5VALW	5V always on power rail	ON	ON	ON*
+5VS	5V switched power rail	ON	OFF	OFF
+VSB	VSb always on power rail	ON	ON	ON*
+RTCVCC	RTC power	ON	ON	ON

Note : ON\* means that this power plane is ON only with AC power available, otherwise it is OFF.

EC SM Bus1 address                      EC SM Bus2 address

Device	Address	HEX	Device	Address	HEX
Smart Battery	000 1011	11h 0x16	ADM1032ARMZ	100 1101	4Dh 0x9A
Charger IC	000 1001	09h 0x12	SB-TSI	100 1100	4Ch 0x98
			RTD2136	100 1010	4Ah 0x94
			GPU	100 0001	41h 0x82

SM Bus Controller 0                      (FCH\_SMB1 ~ FCH\_SMB4, SMB\_ALERT#)

Device	Address	HEX
APU SIC/SID (FCH_SMB3)		

SM Bus Controller 1                      (FCH\_SMB0)

Device	Address	HEX
DDR DIMM1 (FCH_SMB0)	1001-000xb	90
DDR DIMM2 (FCH_SMB0)	1001-001xb	92
WLAN (FCH_SMB0)		

FCH Hudson-M3 SATA Port List	
SATA0	HDD
SATA1	ODD
SATA2	NC
SATA3	NC
SATA4	NC
SATA5	NC

Comal PCIE Port List		
APU	PCIE0	LAN
	PCIE1	WLAN
	PCIE2	ExCARD
	PCIE3	NC
FCH	PCIE0	NC
	PCIE1	NC
	PCIE2	NC
	PCIE3	NC

FCH Hudson-M3 USB Port List	
USB1.1	
Port0	NC
Port1	NC
USB2.0	
Port0	DEBUG PORT
Port1	WLAN
Port2	NC
Port3	FingerPrint
Port4	NC
Port5	NC
Port6	NC
Port7	CardReader
Port8	ExCARD
Port9	CAM
Port10	LP1
Port11	LP2
Port12	RP1
Port13	RP2

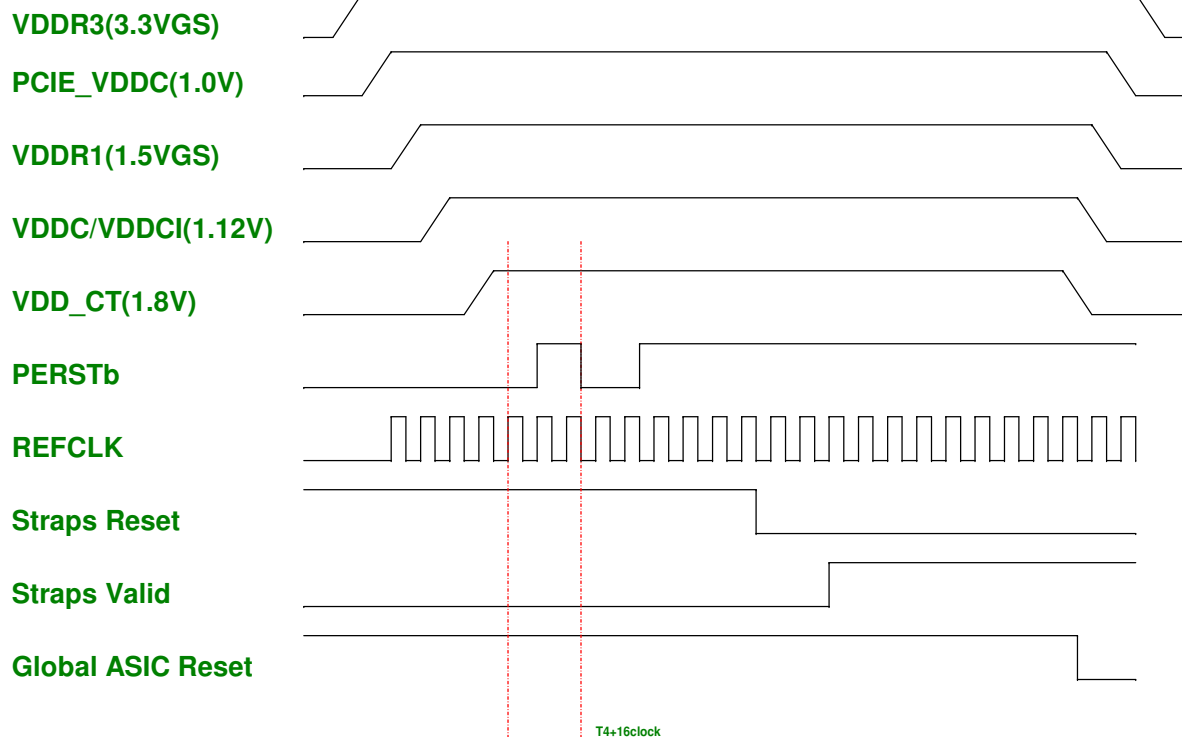
FCH Hudson-M3 USB Port List	
Port0	LP1
Port1	LP2
Port2	RP1
Port3	RP2

BOM Structure

UMA@ : UMA only  
DIS@ : DIS muxluss  
45@ : 45 Level  
9012@: EC9012  
930@: EC930  
INS@: Inspiron  
VOS@: Vostro  
M2@: FCH M2  
M3@: FCH M3  
FFS@: FreeFallSensor  
EXP@: Express Card  
FP@: FingerPrint  
EMC@: EMI&ESD part  
  
SE@: SEYMOUS GPU  
CH@: Chelsea GPU  
X76@: VRAM  
H2G@: Hynix 2G  
S2G@: Samsung 2G  
R1@: R1 P/N for FCH,PCB  
TMSR1@: R1 P/N for GPU,VRAM  
R3@: R3 P/N for FCH,PCB  
TMSR3@: R3 P/N for GPU,VRAM

## Power-Up/Down Sequence

- All the ASIC supplies, except for VDDR3, must fully reach their respective nominal voltages within 20 ms of the start of the ramp-up sequence, though a shorter ramp-up duration is preferred. There is no timing requirement on the ramp up of VDDR3 relative to other power rails.
- The external pull-up resistors on the DDC/AUX signals (if applicable) should ramp up before or after both VDDC and VDD\_CT have ramped up.
- VDDC and VDD\_CT should not ramp up simultaneously. For example, VDDC should reach 90% before VDD\_CT starts to ramp up (or vice versa).
- For power down, reversing the ramp-up sequence is recommended.



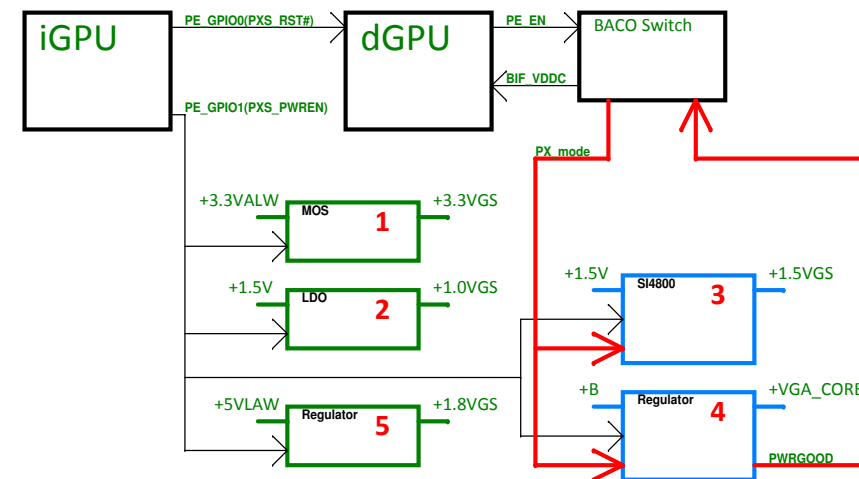
**Without BACO option :**

PE\_GPIO0 : Low -> Reset dGPU ; High -> Normal operation  
PE\_GPIO1 : Low -> dGPU Power OFF ; High -> dGPU Power ON

**BACO option :**

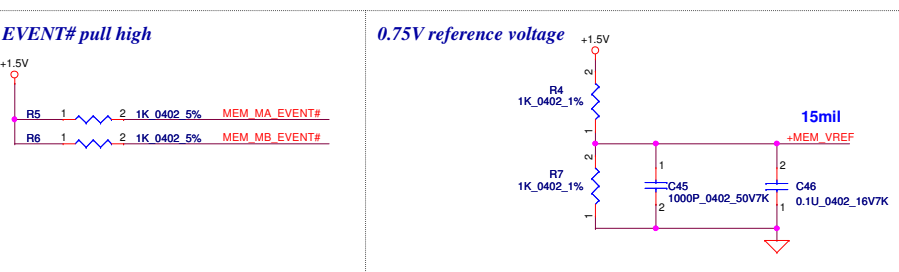
PE\_GPIO0 : High -> Normal operation (dGPU is not reset on BACO mode)  
PE\_GPIO1 : Low -> dGPU Power OFF ; High -> dGPU Power ON (always High)

dGPU Power Pins	Voltage	PX 3.0	BACO Mode	Max current
PCIE_PVDD, PCIE_VDDR, TSVDD, VDDR4, VDD_CT, DPE_PVDD, DP[F:E]_VDD18, DP[D:A]_PVDD, DP[D:A]_VDD18, AVDD, VDD1D1, A2VDDQ, VDD2DI, DPLL_PVDD, MPV18, and SPV18	1.8V	OFF	ON	1679mA
DP[F:E]_VDD10, DP[D:A]_VDD10, DPLL_VDDC, and SPV10	1.0V	OFF	ON	775mA
PCIE_VDDC	1.0V	OFF	ON	1.1A
VDDR3	3.3V	OFF	ON	60mA
BIF_VDDC (current consumption = 55mA@1.0V, in BACO mode)	Same as VDDC	OFF	ON Same as PCIE_VDDC	70mA
VDDR1	1.5V	OFF	OFF	1.2A
VDDC/VDDCI	TBD	OFF	OFF	28

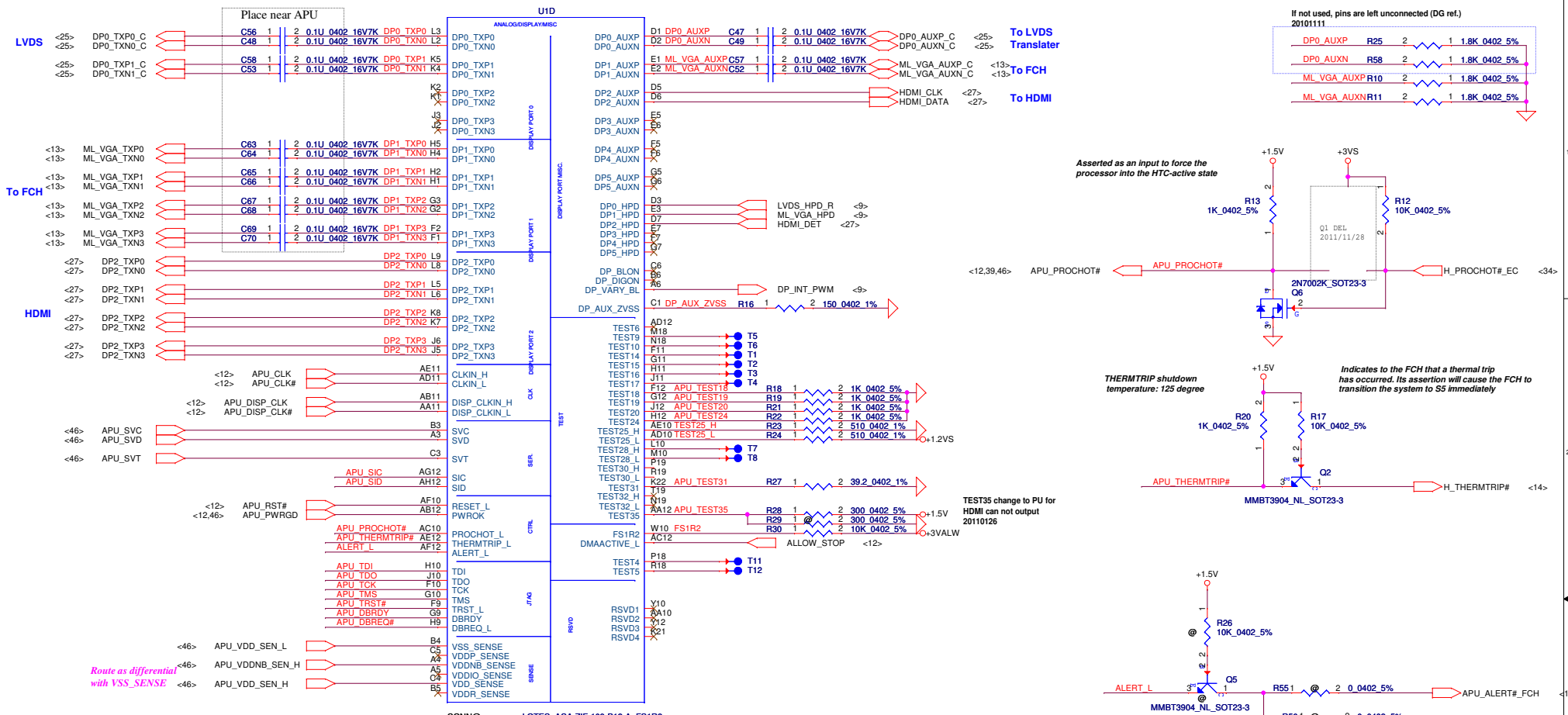


Security Classification		Compal Secret Data		Compal Electronics, Inc.		
Issued Date	2011/08/01	Deciphered Date	2013/01/01	Title		
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				dGPU Block Diagram		
				Size B	Document Number	Rev 1.0
				LA8251P		
Date: Monday, July 16, 2012				Sheet 4 of 50		

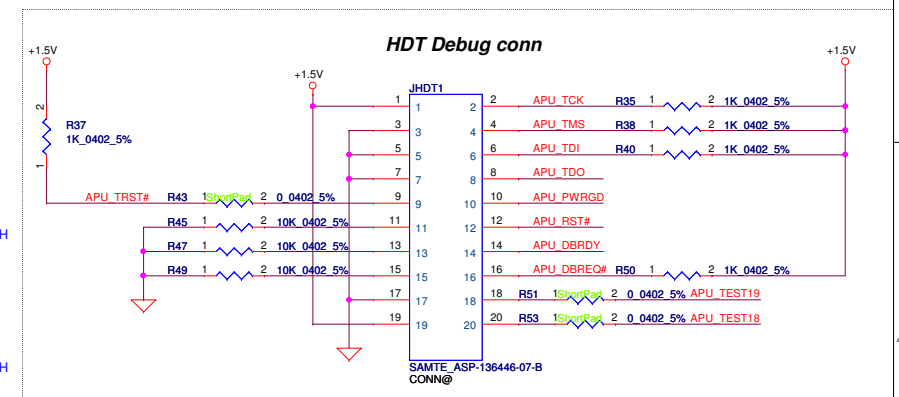
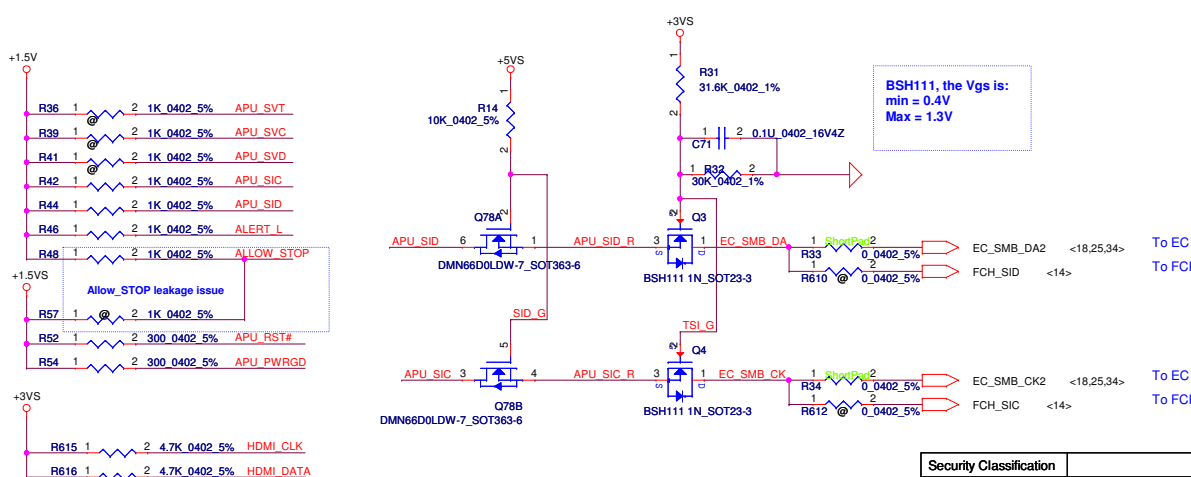




Security Classification	Compal Secret Data			Compal Electronics, Inc.		
Issued Date	2011/08/01	Deciphered Date	2013/01/01	Title	FS1r2 DDRIII Memory I/F	
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF THE DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Size	Document Number	Rev
				Custom	LA8251P	1.0
Date:	Monday, July 15, 2013			16:00	6 of 50	



CPU TSI interface level shift

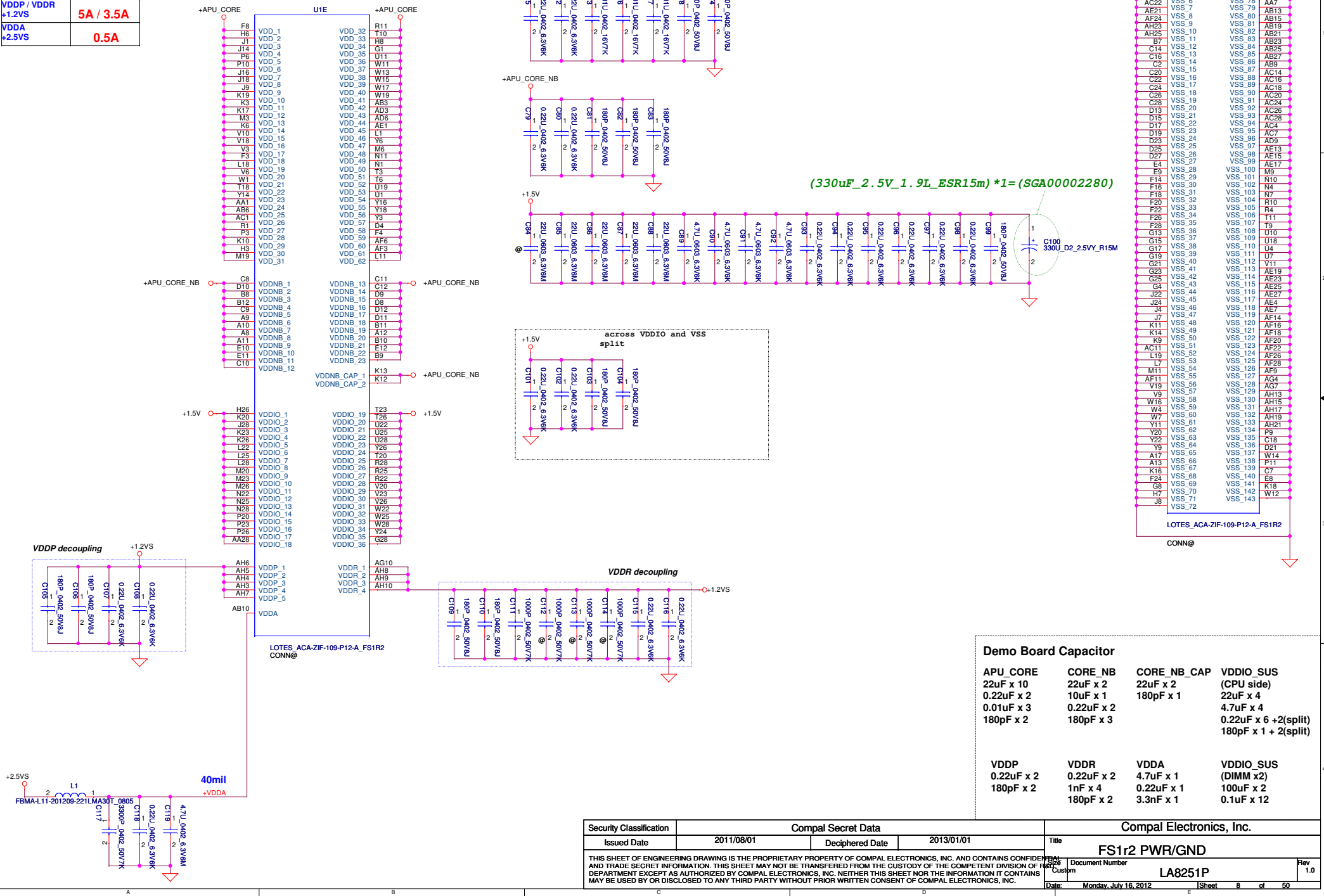


Aux signal are re-configured as I2C signals for DDC. APU AUX pin are 3.3V tolerant  
Default follow PANGX setting for pull-high resistor value

Security Classification		Compal Secret Data		Compal Electronics, Inc.	
Issued Date	2011/08/01	Deciphered Date	2013/01/01	Title	
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF FIRST DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Document Number	Rev
				LA8251P	1.0
				Date: Monday, July 16, 2012	E[Sheet 7 of 50]



Power Name	Consumption
VDD +APU_CORE	60A
VDDNB +APU_CORE_NB	29A
VDDIO +1.5V	3.2A
VDDP / VDDR +1.2VS	5A / 3.5A
VDDA +2.5VS	0.5A

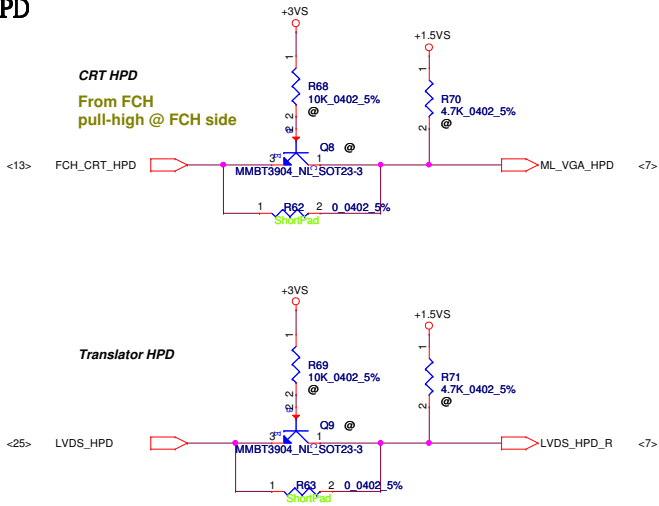


$(330\mu F \cdot 2.5V \cdot 1.9L_{ESR15m}) \cdot \pi = (SGA00002280)$

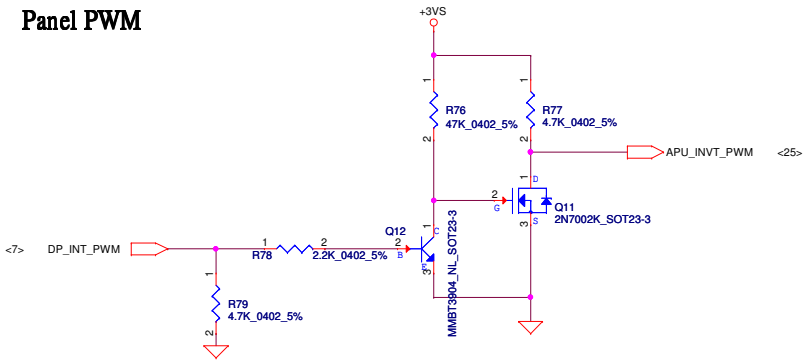
Security Classification				Compal Secret Data				Compal Electronics, Inc.			
Issued Date				2011/08/01				Title			
Deciphered Date				2013/01/01				FS1r2 PWR/GND			
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF PRODUCT DEVELOPMENT DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Date				Monday, July 16, 2012			
								Rev			
								1.0			

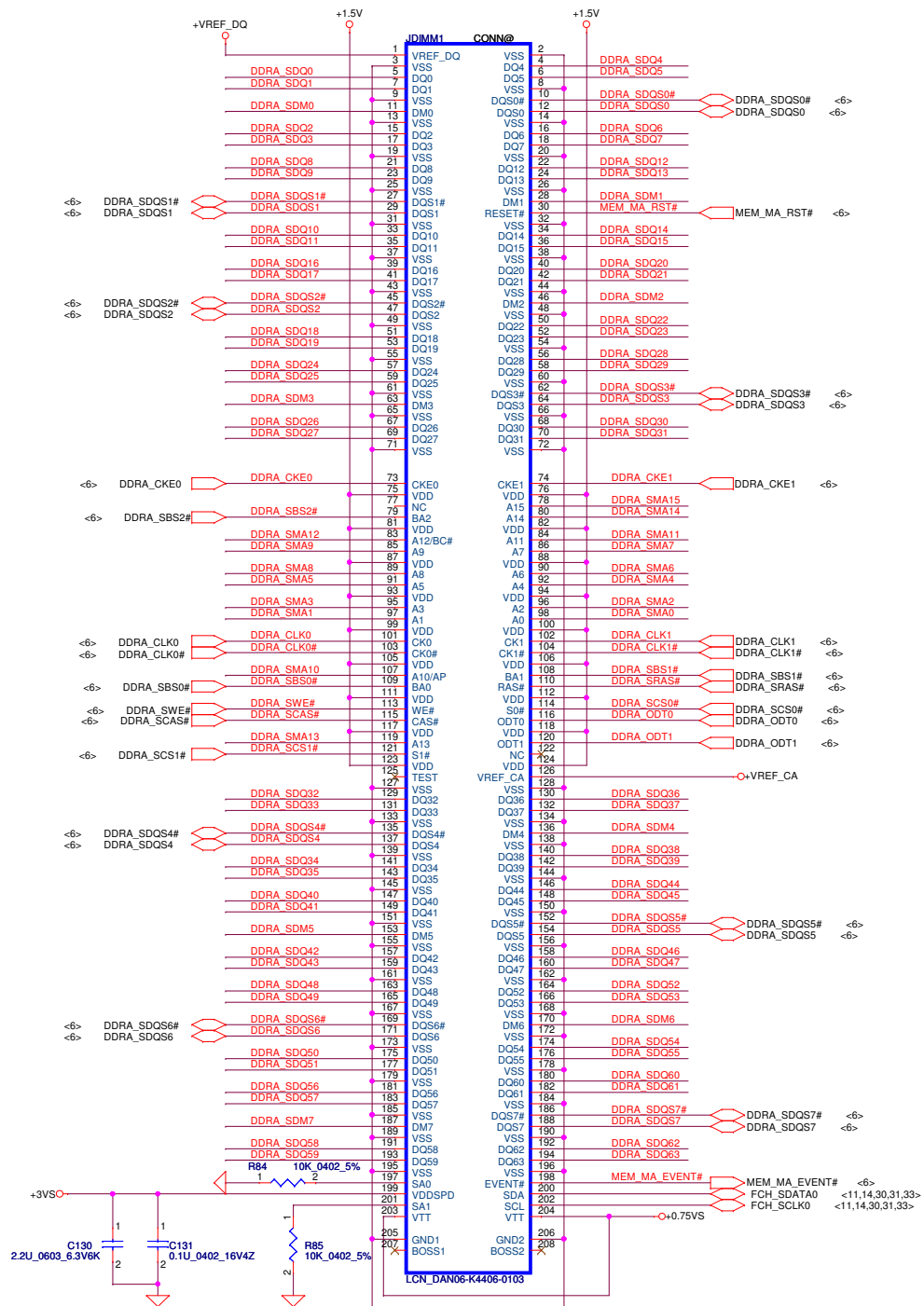


HPD

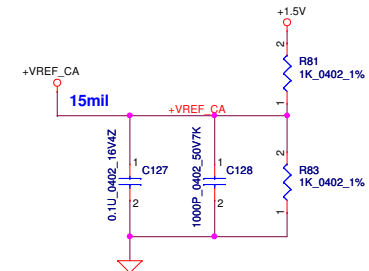
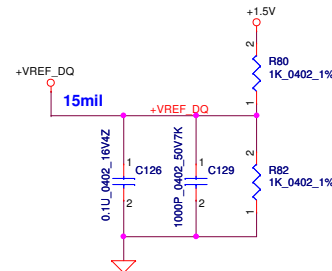
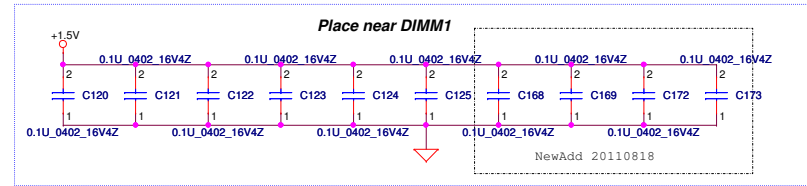


Panel PWM



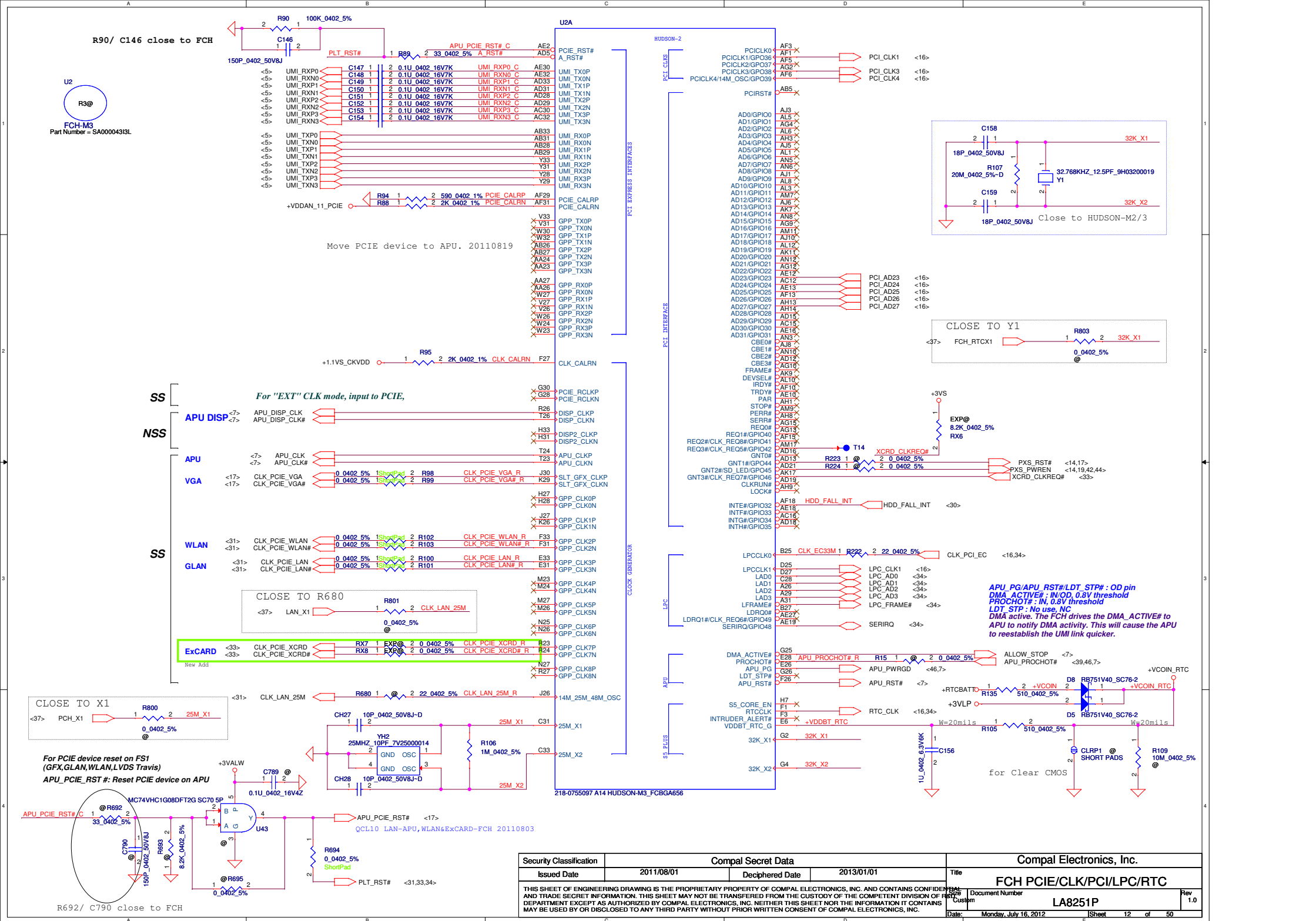


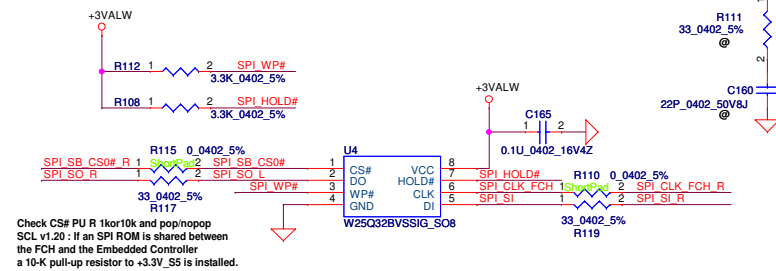
DDR\_A\_SDQ[0..63] <6>  
 DDR\_A\_SDM[0..7] <6>  
 DDR\_A\_SMA[0..15] <6>



Security Classification		Compal Secret Data				Compal Electronics, Inc.							
Issued Date		2011/08/01		Deciphered Date		2013/01/01		Title					
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF FIRST DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.								DDRIII SO-DIMM 1					
								Document Number		LA8251P		Rev 1.0	
								Date		Monday, July 16, 2012		Sheet 10 of 50	





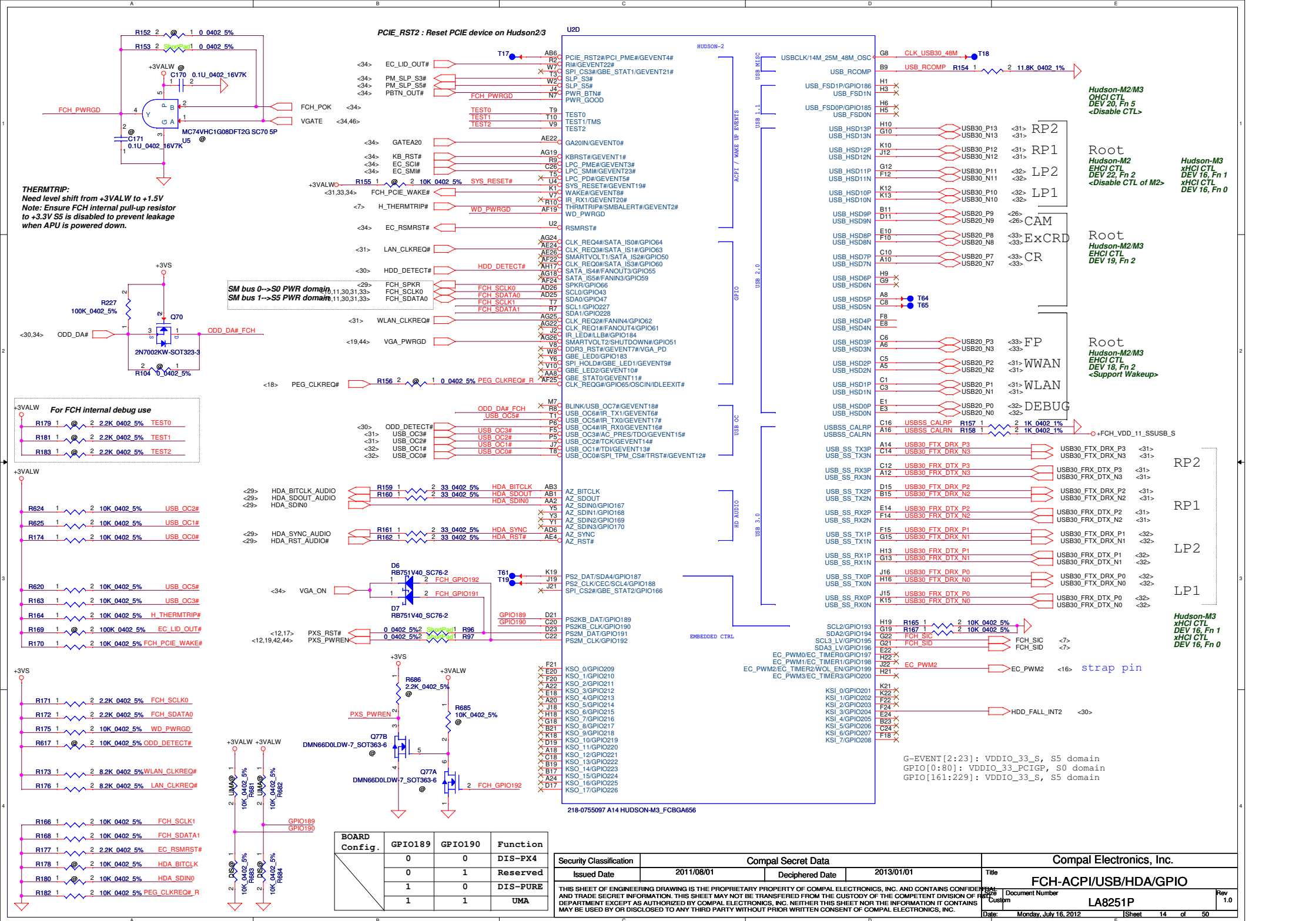


GBE\_PHY\_INTR  
Pulled-up to +3.3V\_S5 with a 10-KΩ 5% resistor.  
FCH SCL V1.20 #19-85

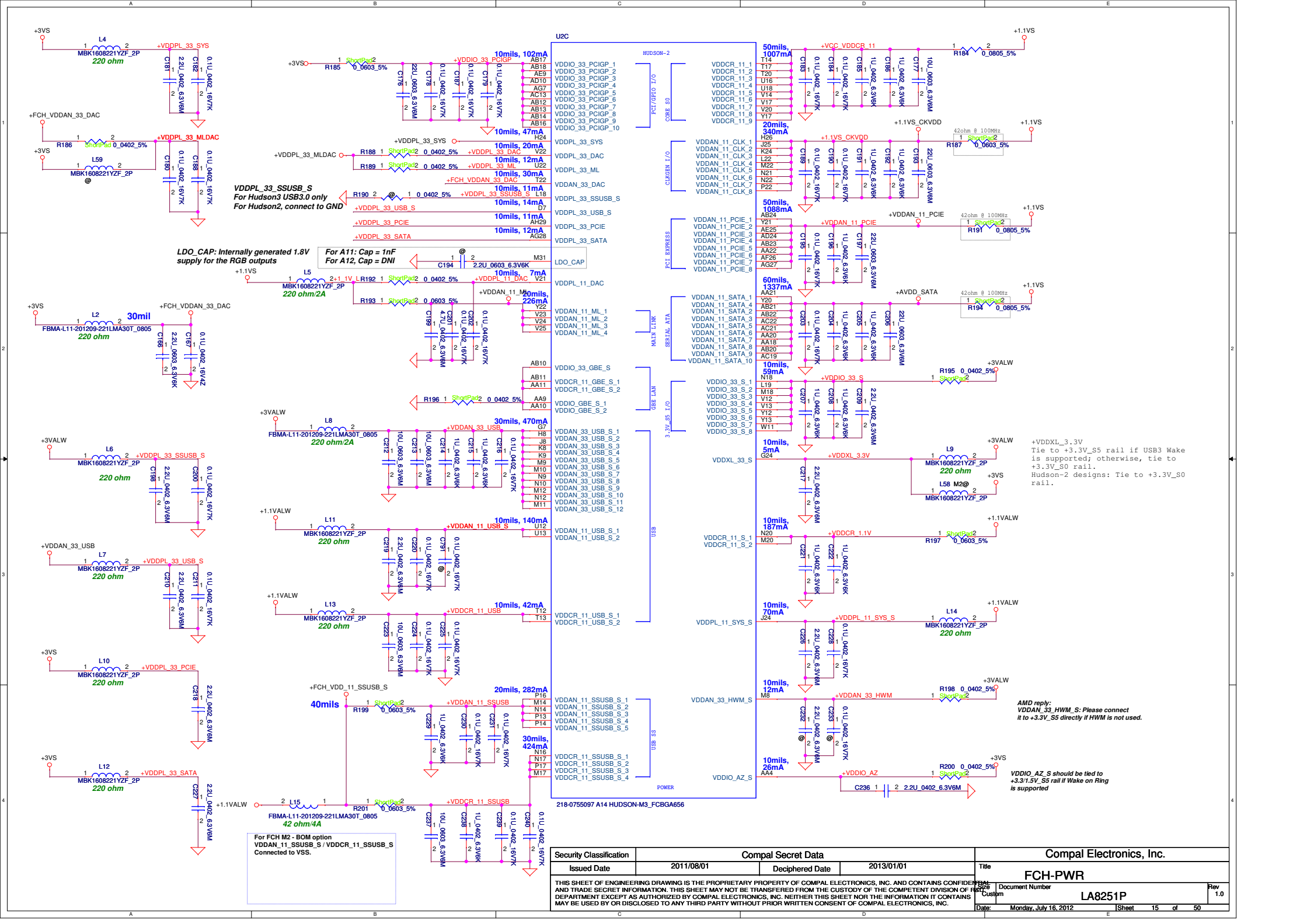
GBE\_PHY\_INTR R121 1 2 10K 0402 5% +3VALW

Removed RGMII/MII support and updated termination requirements for GBE\_COL, GBE\_CRS, GBE\_RXERR and GBE\_MDIO when RGMII/MII interface is not used.  
FCH DgV1.20 / SCL V1.20

Security Classification		Compal Secret Data		Compal Electronics, Inc.		
Issued Date	2011/08/01	Deciphered Date	2013/01/01	Title	FCH SATA/SPI/VGA/HWM/SD	
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF FCH DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Document Number	Rev	
				Custom	L8A251P1.0	
				Date: Monday, July 16, 2012	Sheet	13 of 50









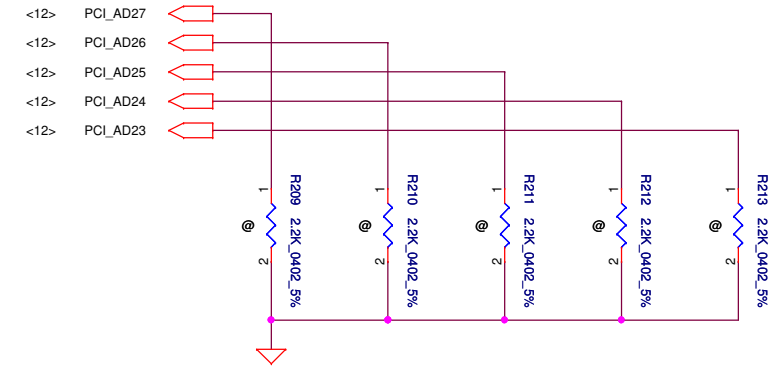
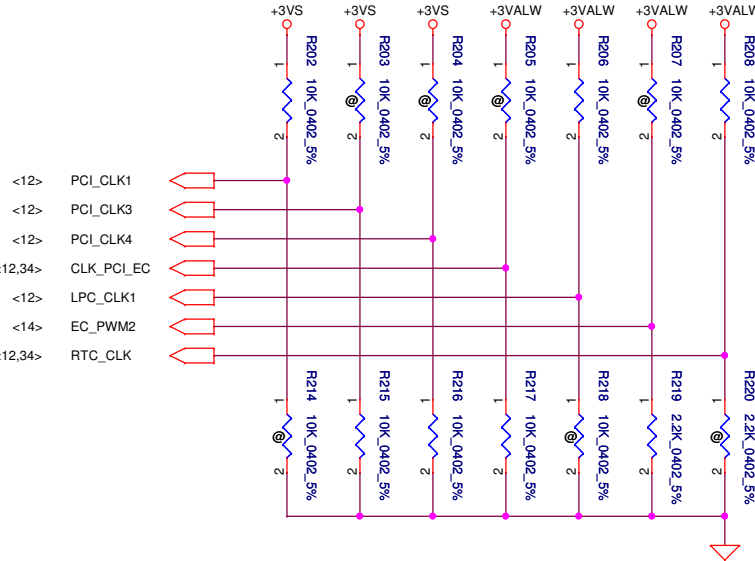
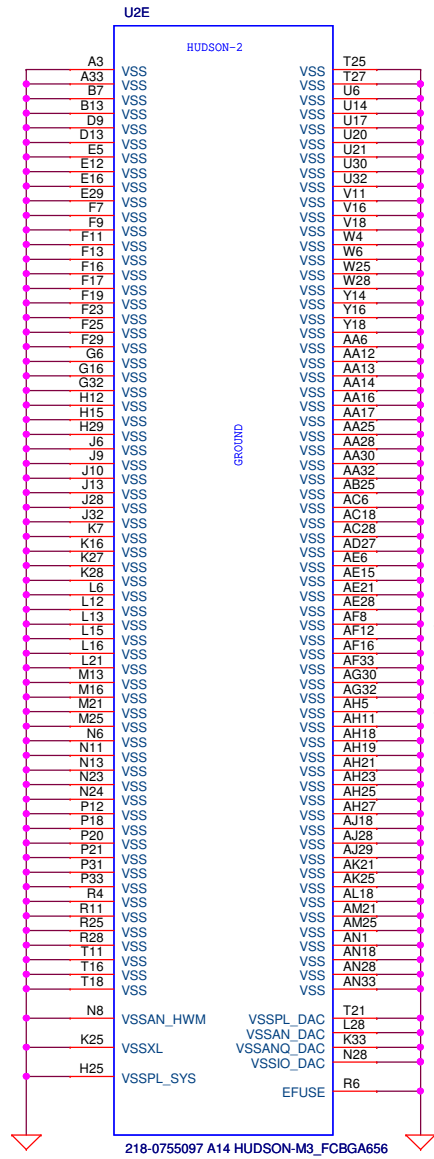
## STRAP PINS

	PCI_CLK1	PCI_CLK3	PCI_CLK4	LPC_CLK0_EC	LPC_CLK1	EC_PWM2	RTC_CLK
PULL HIGH	ALLOW PCIE GEN2 DEFAULT	USE DEBUG STRAPS	NON FUSION CLOCK MODE	EC ENABLED	CLKGEN ENABLED DEFAULT	LPC ROM	S5 PLUS MODE DISABLED DEFAULT
PULL LOW	FORCE PCIE GEN1	IGNORE DEBUG STRAP DEFAULT	FUSION CLOCK MODE DEFAULT	EC DISABLED DEFAULT	CLKGEN DISABLE	SPI ROM DEFAULT	S5 PLUS MODE ENABLED

## DEBUG STRAPS

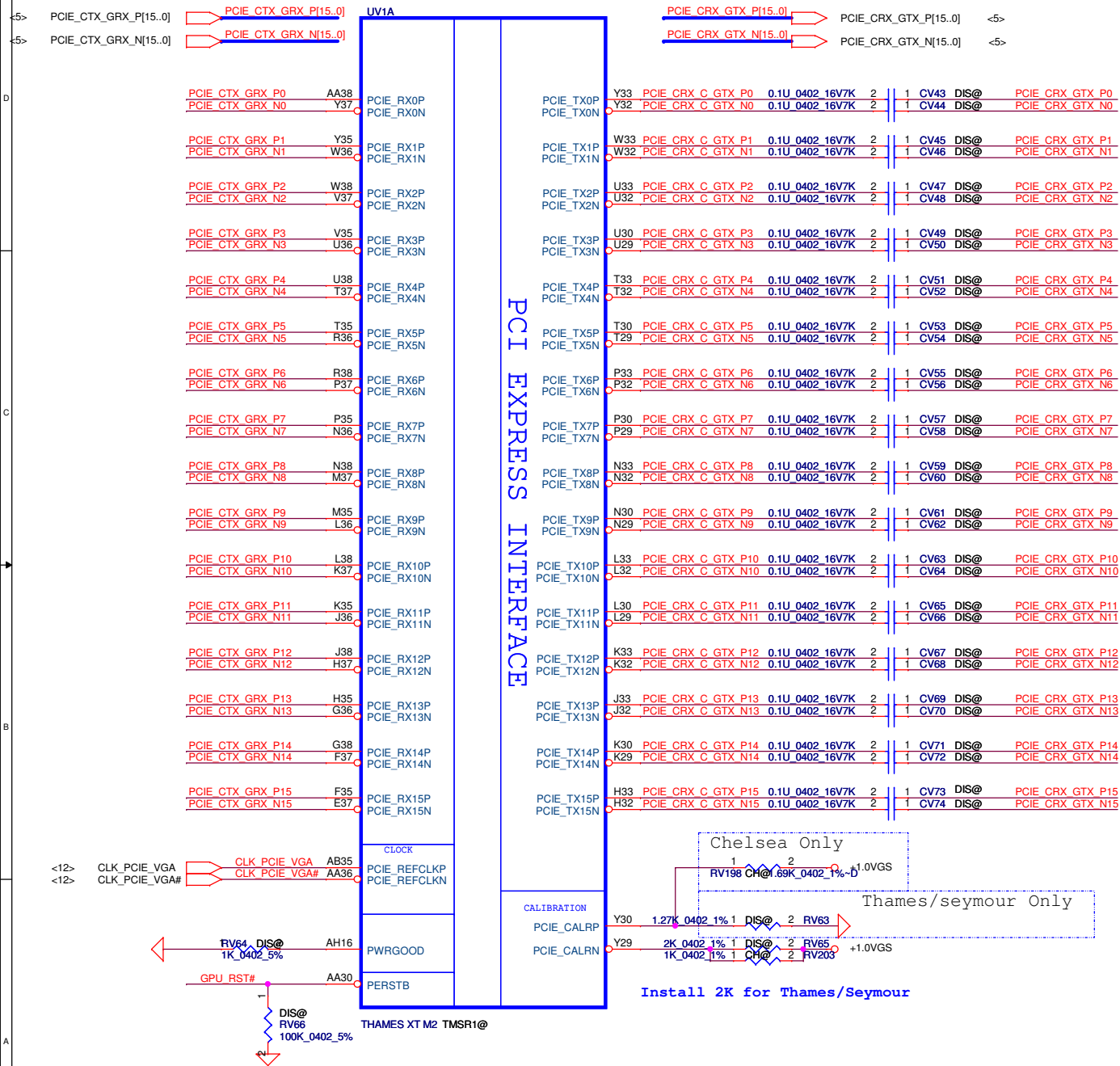
FCH HAS 15K INTERNAL PU FOR PCI\_AD[27:23]

	PCI_AD27	PCI_AD26	PCI_AD25	PCI_AD24	PCI_AD23
PULL HIGH	USE PCI PLL DEFAULT	DISABLE ILA AUTORUN DEFAULT	USE FC PLL DEFAULT	USE DEFAULT PCIE STRAPS DEFAULT	DISABLE PCI MEM BOOT DEFAULT
PULL LOW	BYPASS PCI PLL	ENABLE ILA AUTORUN	BYPASS FC PLL	USE EEPROM PCIE STRAPS	ENABLE PCI MEM BOOT

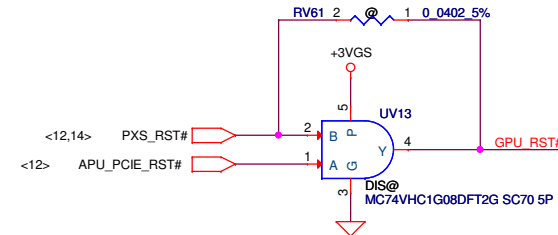
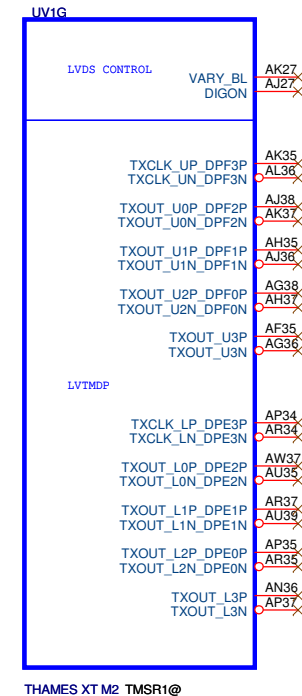


Security Classification	Compal Secret Data			Compal Electronics, Inc.	
Issued Date	2011/08/01	Deciphered Date	2013/01/01	Title	FCH-VSS/Strap
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Size B	Document Number LA8251P
				Date: Monday, July 16, 2012	Sheet 16 of 50

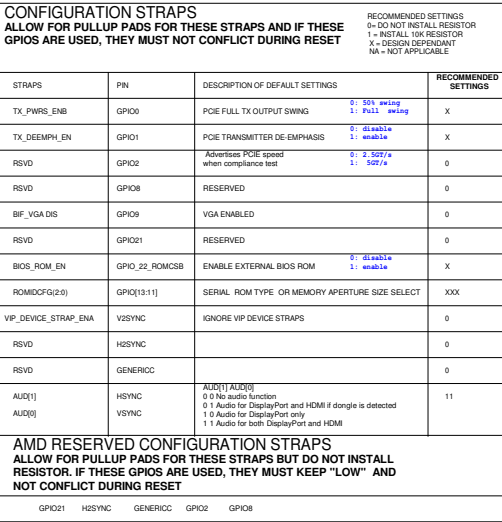
# GFX PCIE LANE REVERSAL



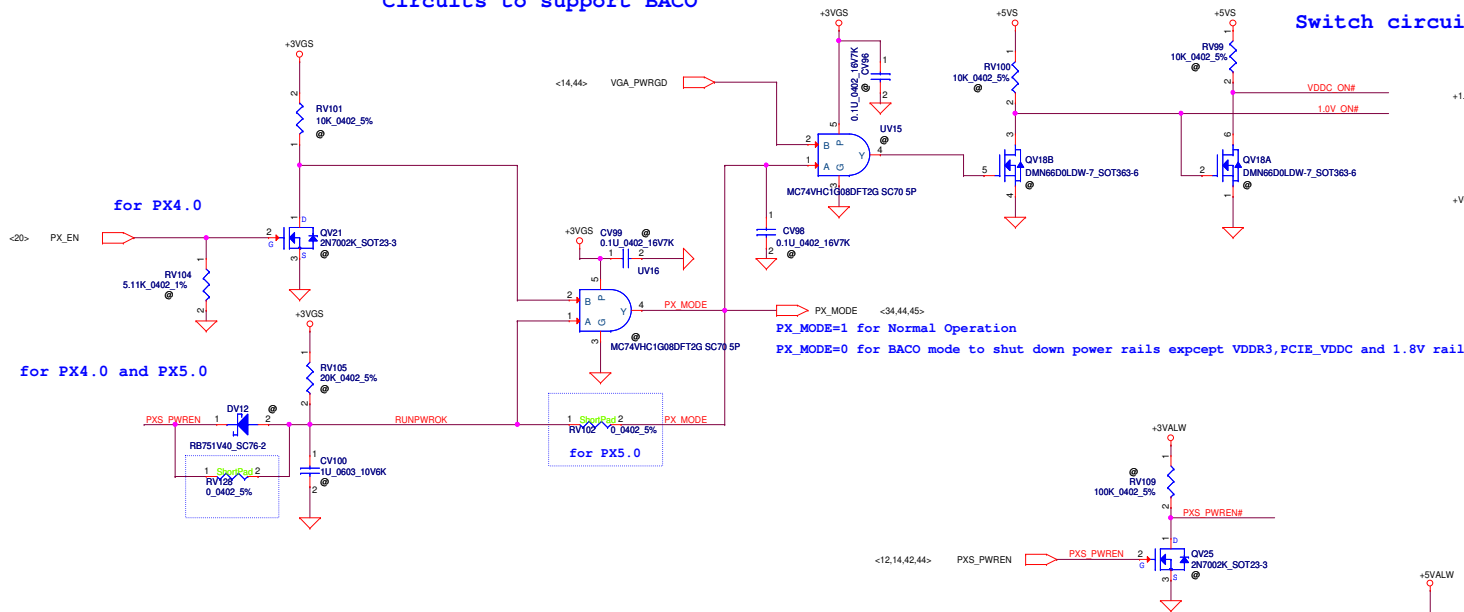
## LVDS Interface



Security Classification		Compal Secret Data		Compal Electronics, Inc.	
Issued Date	2011/08/01	Deciphered Date	2013/01/01	Title	ATI SeymourXT_M2_PCIE/LVDS
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Document Number	LA8251P
				Date	Monday, July 16, 2012
				Sheet	17 of 50



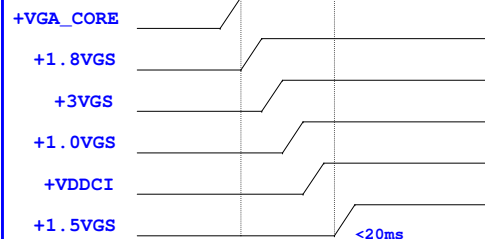
## Circuits to support BACO



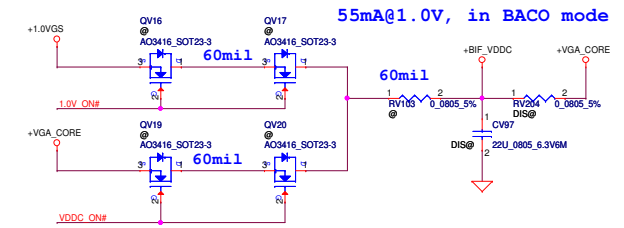
### Note:

PX4.0 +VGA\_CORE, VDDCI, +1.5VGS OFF  
 PX4.0 +3VGS, +1.0VGS, +1.8VGS ON  
 PX5.0 +3VGS, +VGA\_CORE, VDDCI, +1.5VGV, +1.0VGS, +1.8VGS OFF

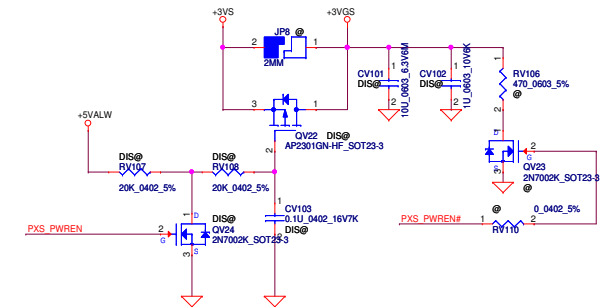
## Power Sequence of Thames and Chelsea



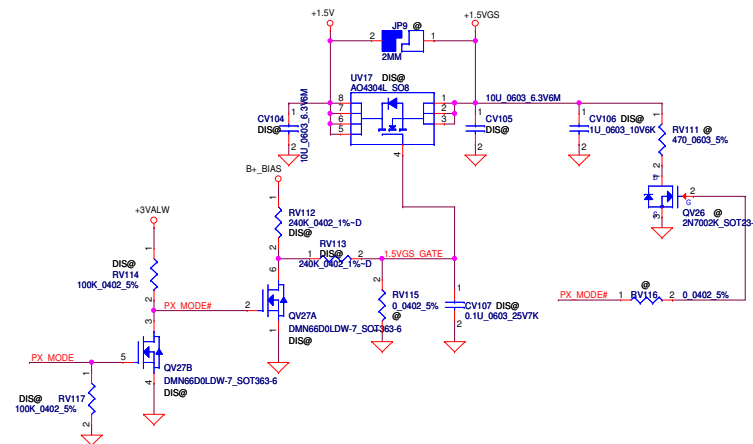
## Switch circuits in BACO designs for Thames/Seymour only



## +3.3VS TO +3.3VGS



## +1.5V TO +1.5VGS



Security Classification	Compal Secret Data		Compal Electronics, Inc.	
Issued Date	2011/08/01	Deciphered Date	2013/01/01	Title
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				ATI SeymourXT M2 BACO POWER
Size	C	Document Number	LA8251P	Rev 1.0
Date:	Monday, July 16, 2012	Sheet	19	of 50



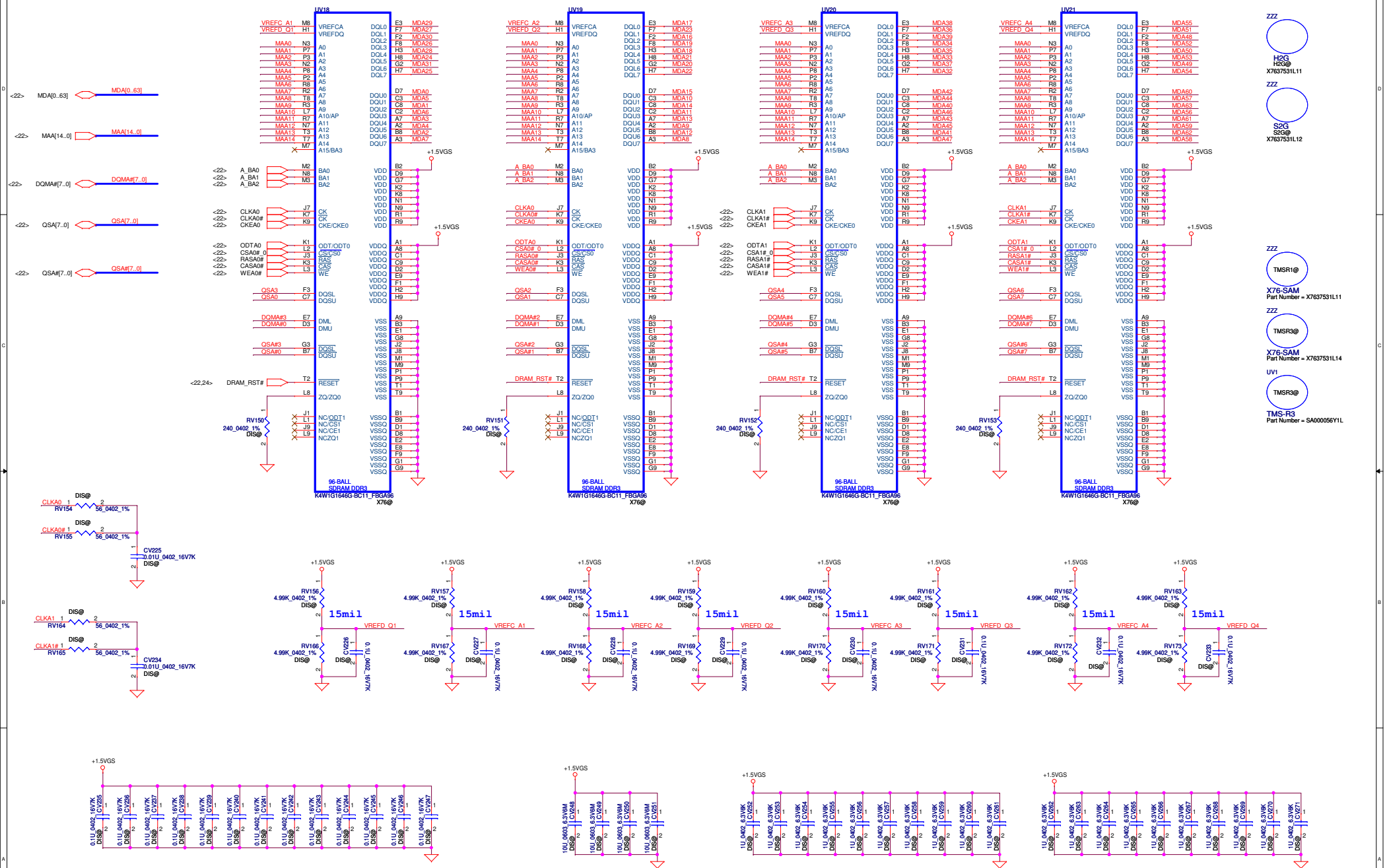






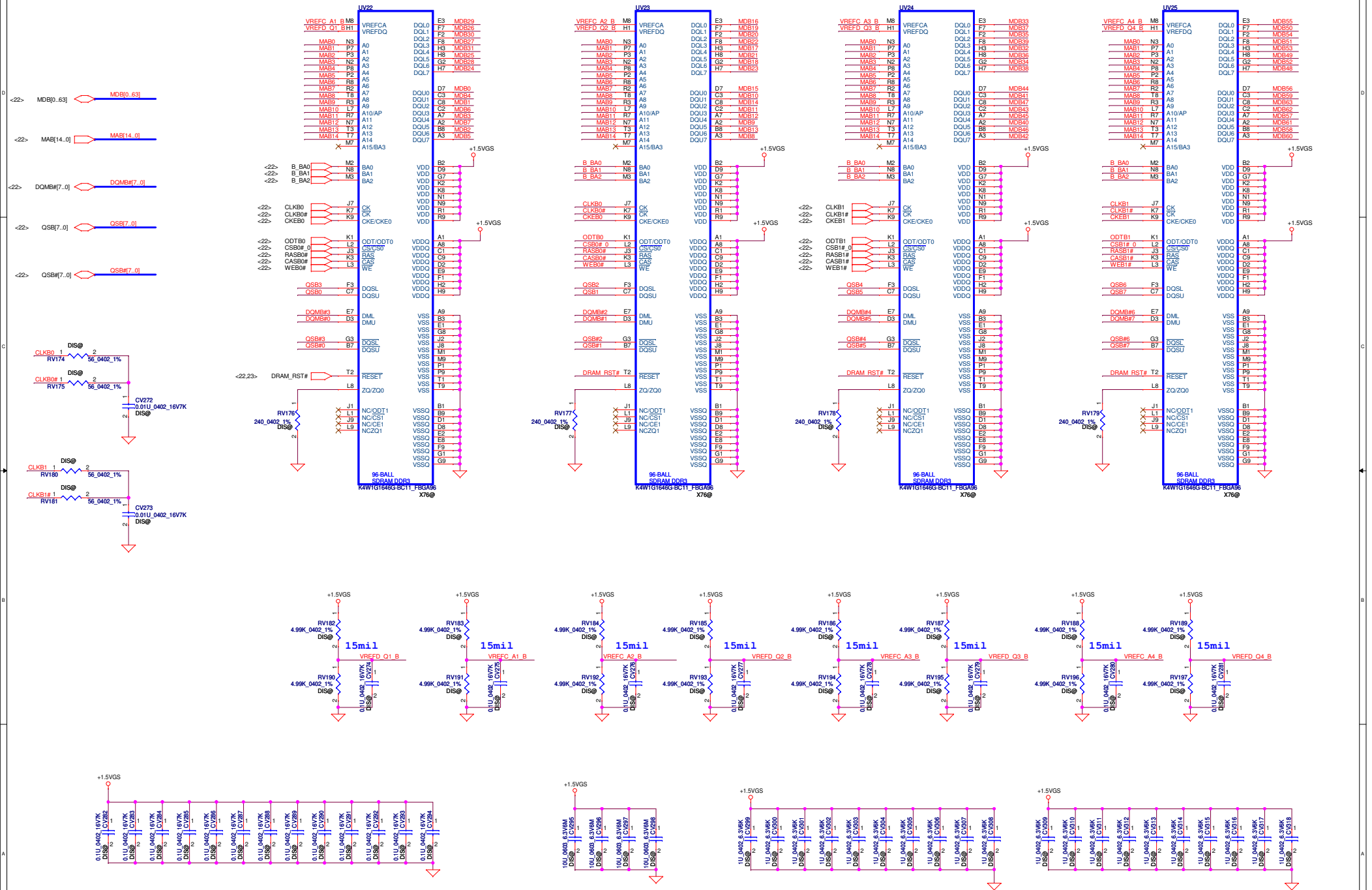


CHANNEL A: 256MB/512MB DDR3



Security Classification		Compal Secret Data		Compal Electronics, Inc.							
Issued Date		2011/08/01	Deciphered Date		2013/01/01	Title					
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.						ATI SeymourXT M2 VRAM A					
						Size C	Document Number				Rev 1.0
						LA8251P					
Date: Monday, July 16, 2012						Sheet 23 of 50					

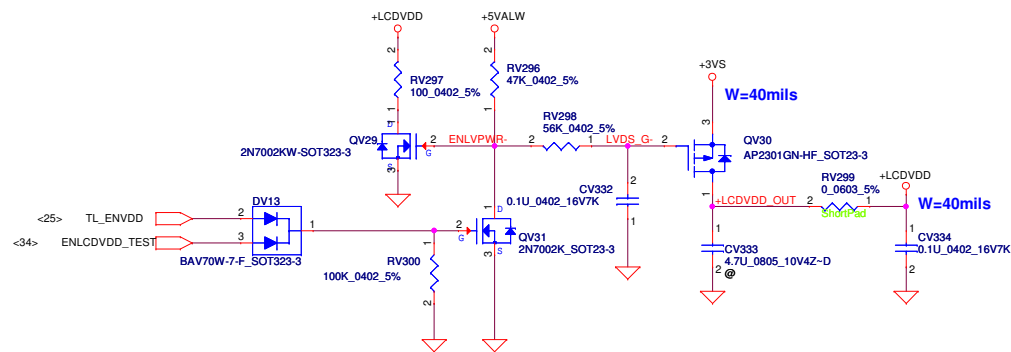
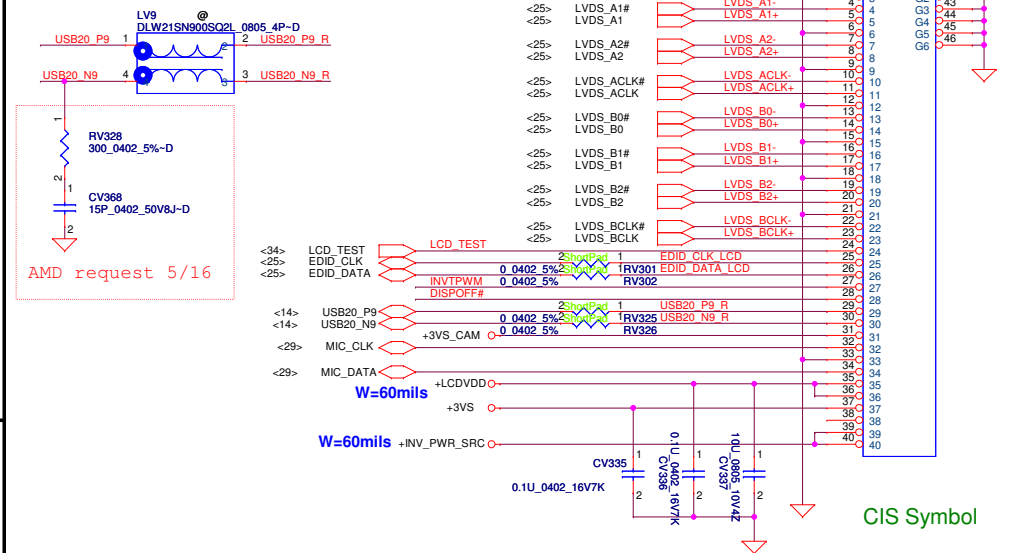
# CHANNEL B: 256MB/512MB DDR3



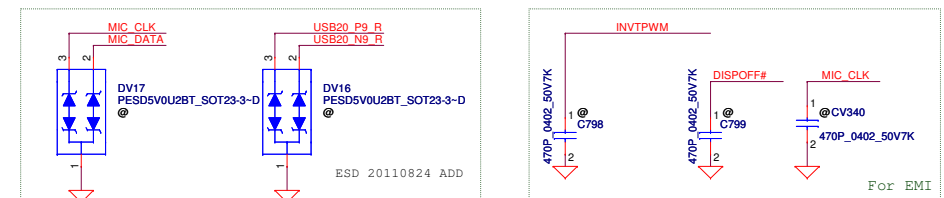
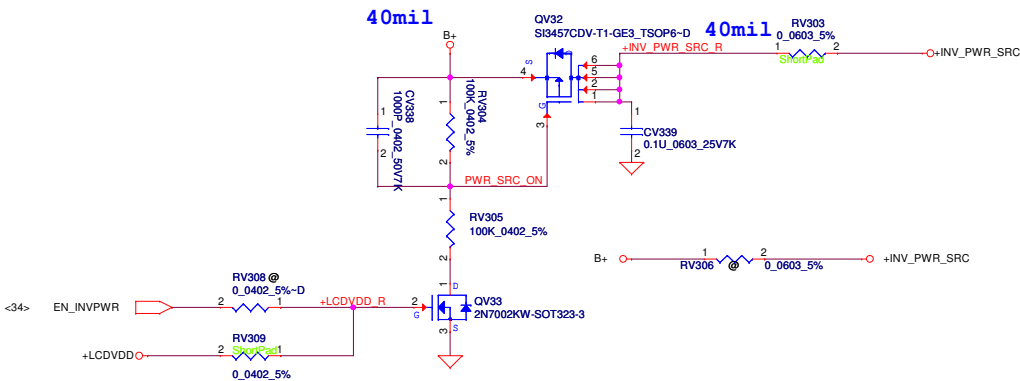
Security Classification	Compal Secret Data		Compal Electronics, Inc.	
Issued Date	2011/08/01	Deciphered Date	2013/01/01	Title
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				ATI SeymourXT M2 VRAM B
Size C	Document Number	LA8251P		Rev 1.0
Date: Monday, July 16, 2012	Sheet 24	of 50		



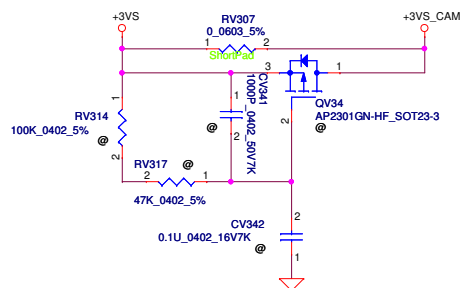
*LCD PWR CTRL*

**LVDS Conn.**

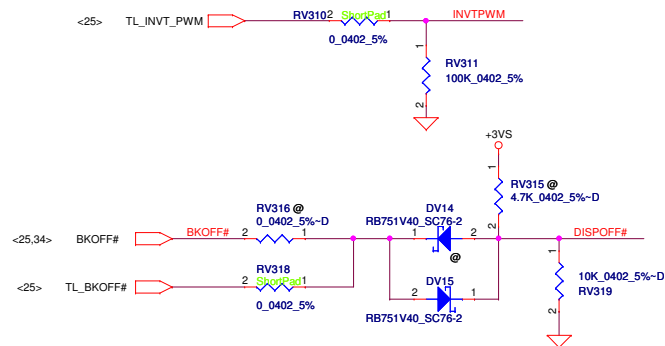
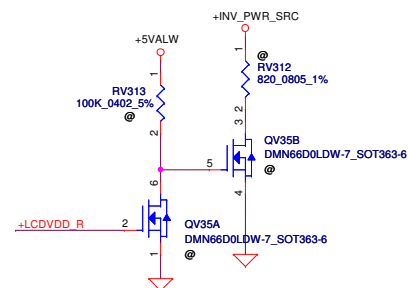
## LCD backlight PWR CTRL



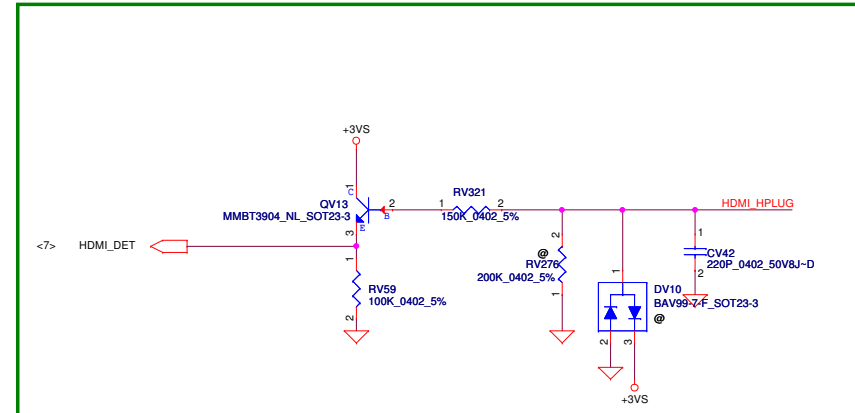
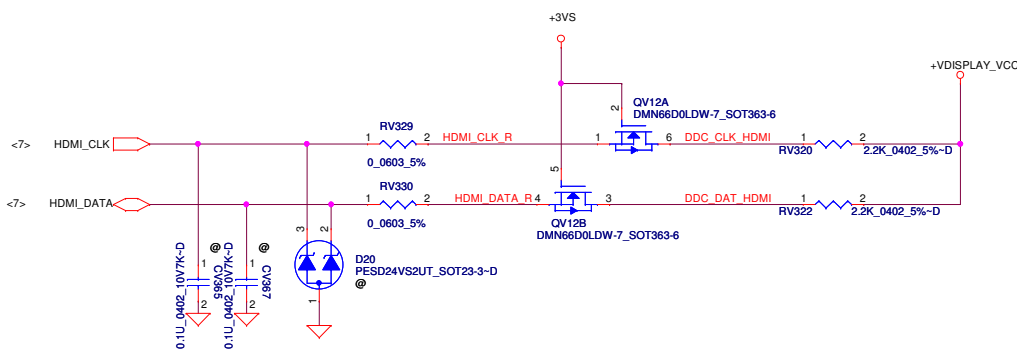
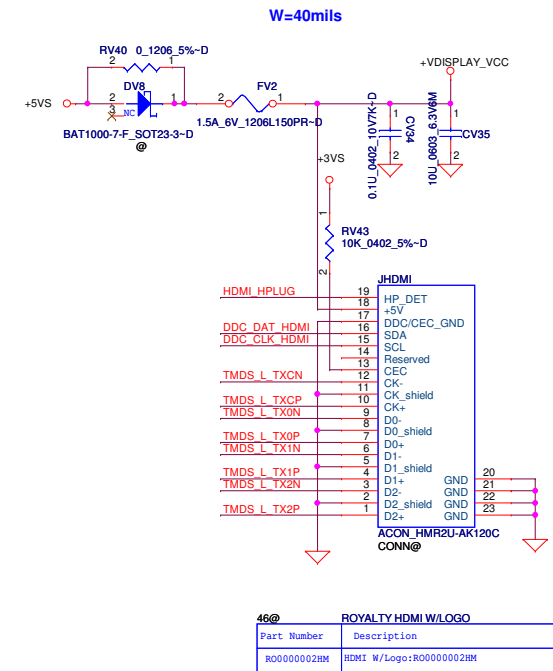
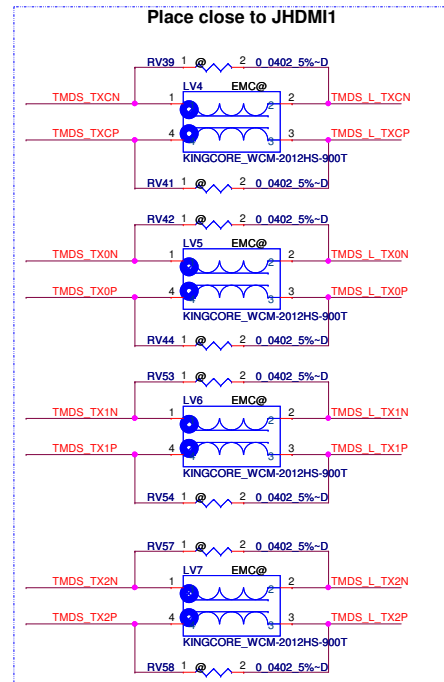
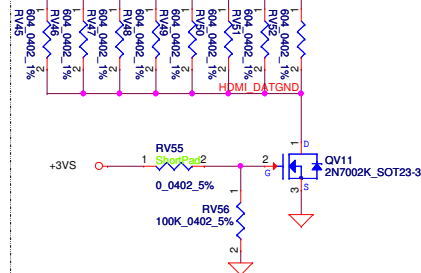
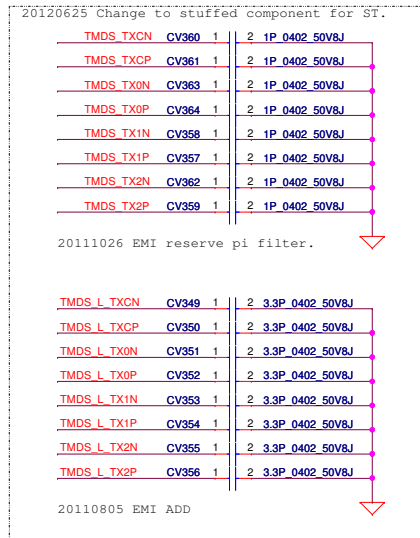
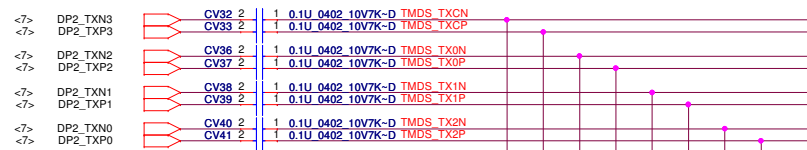
**Wedcam PWR CTRL**



\* Reserved for LCD  
sequence tuning

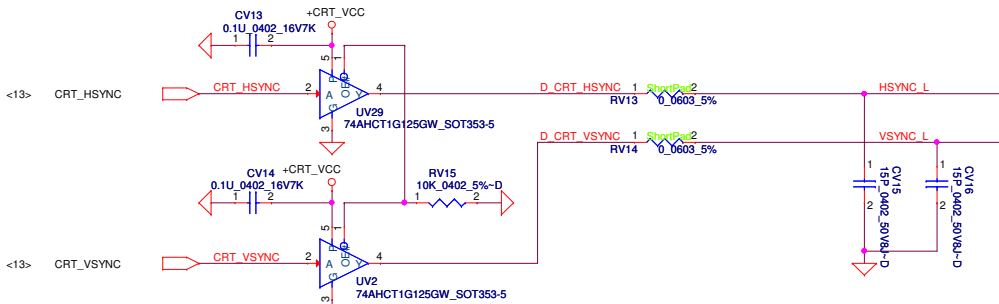
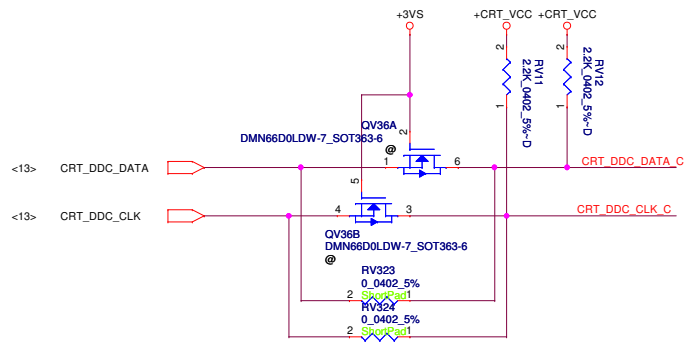
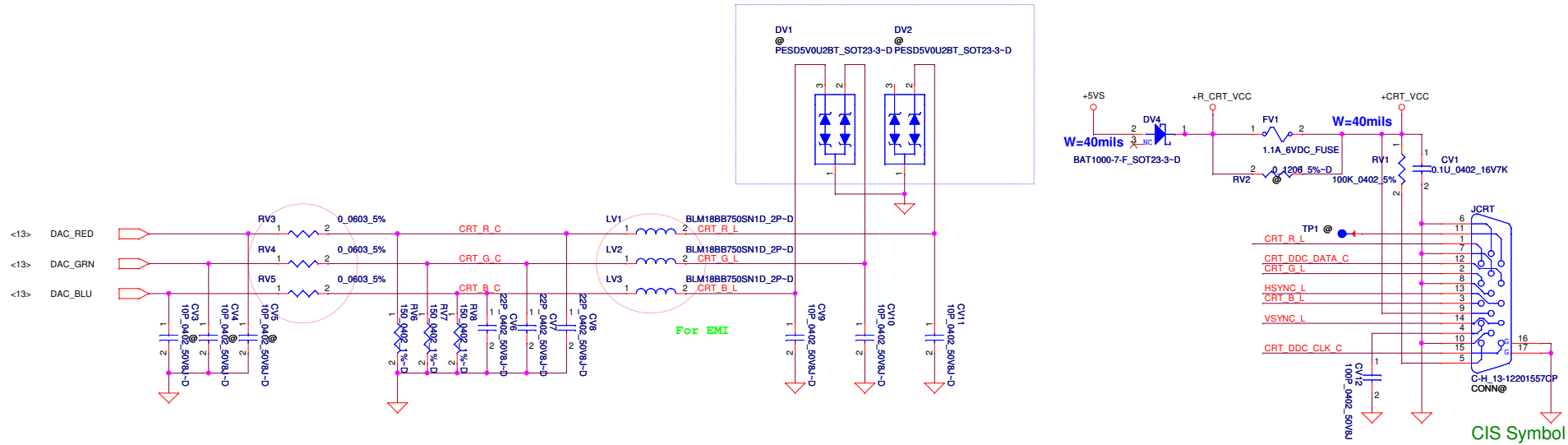


Security Classification		Compal Secret Data		<div style="text-align: right;"><b>Compal Electronics, Inc.</b></div>	
Issued Date	2011/08/01	Deciphered Date	2013/01/01	Title	LVDS/CAMERA
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF RESEARCH AND DEVELOPMENT DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Document Number	Rev
				LA8251P	1.0
Date: Monday, July 16, 2012		Sheet 26 of 50			

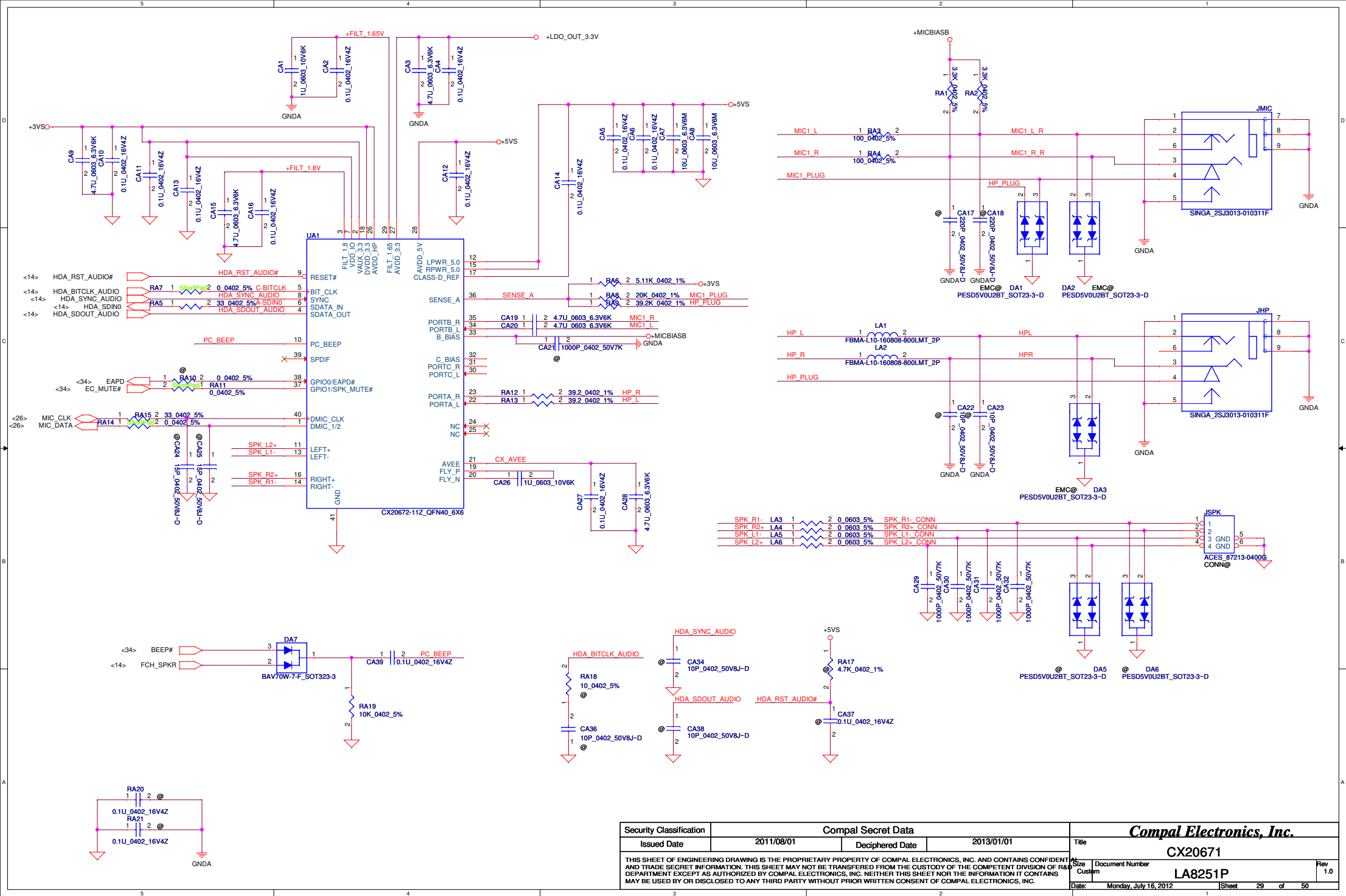


Security Classification		Compal Secret Data		<b>Compal Electronics, Inc.</b> <b>HDMI</b>	
Issued Date	2011/08/01	Deciphered Date	2013/01/01	Title	
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF THE DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Part Number <b>LA8251P</b>	Rev 1.0
				Date: Monday, July 16, 2012         Sheet 27 of 50	

C R T

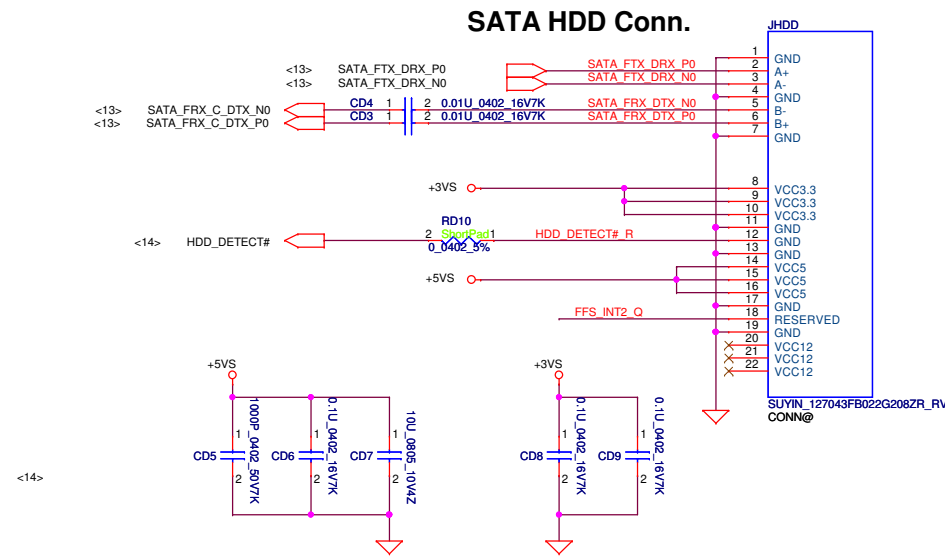
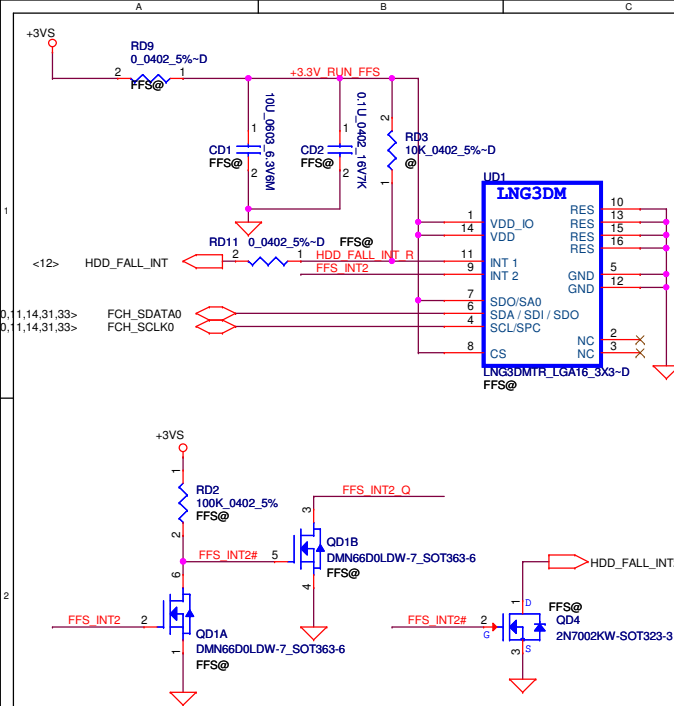


Security Classification		Compal Secret Data		Compal Electronics, Inc.	
Issued Date	2011/08/01	Deciphered Date	2013/01/01		
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Title	
				CRT Conn.	
				Document Number	
				LA8251P	
				Date: Monday, July 16, 2012	
				Sheet 28 of 50	
				Rev	1.0

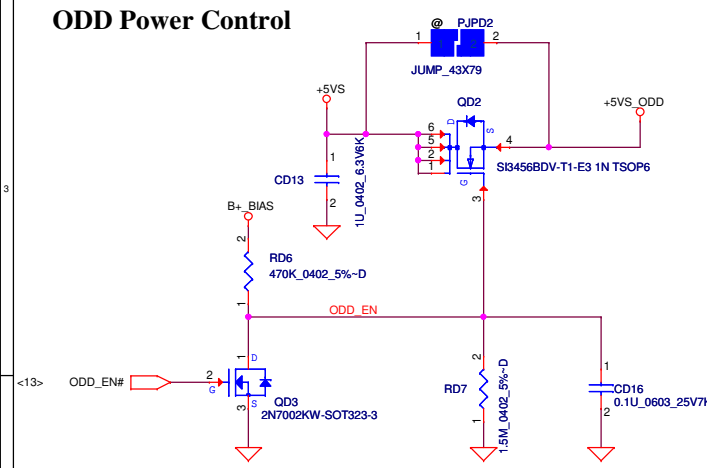


Security Classification		Compal Secret Data		Title	
Issued Date	2011/08/01	Deciphered Date	2013/01/01	CX20671	
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF RA00 DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Size Custom	Rev 1.0
Date: Monday, July 16, 2012		Sheet 29 of 50		LA8251P	

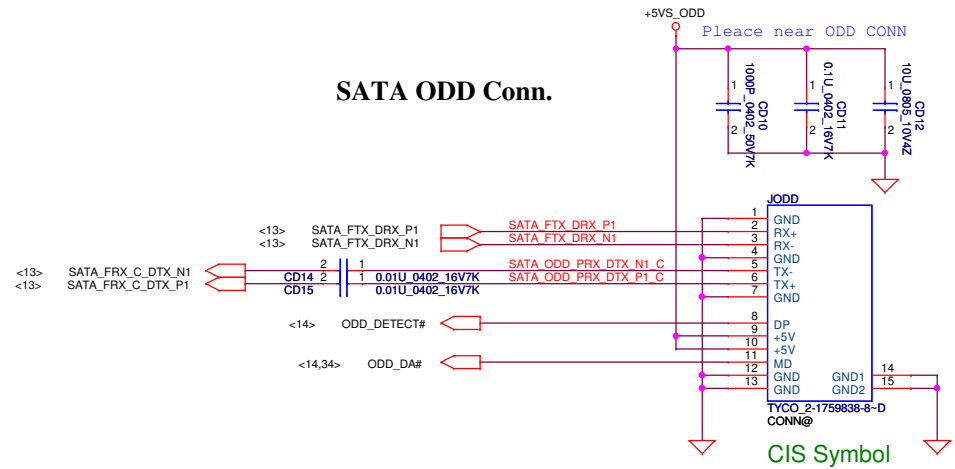




## ODD Power Control

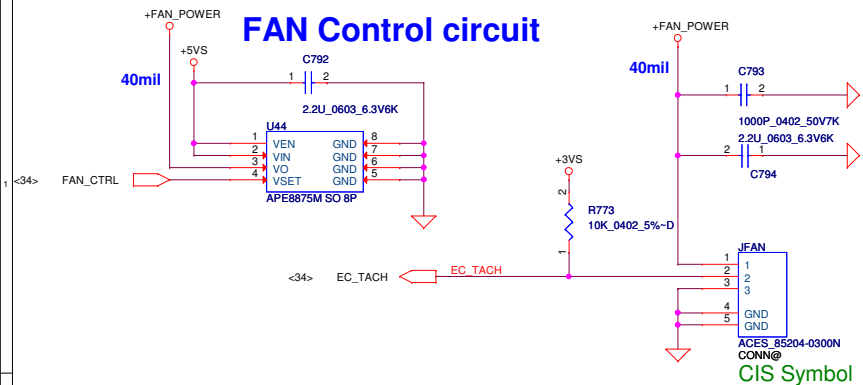


## SATA ODD Conn.

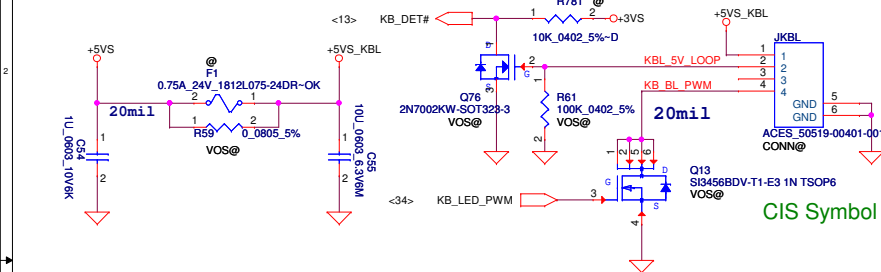


Security Classification	Compal Secret Data			Compal Electronics, Inc.	
Issued Date	2011/08/01	Deciphered Date	2013/01/01	Title	
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				HDD/ODD/FAN	
				Size	Rev
				Custom	1.0
				LA8251P	
				Date:	Monday, July 16, 2012
				Sheet	30 of 50

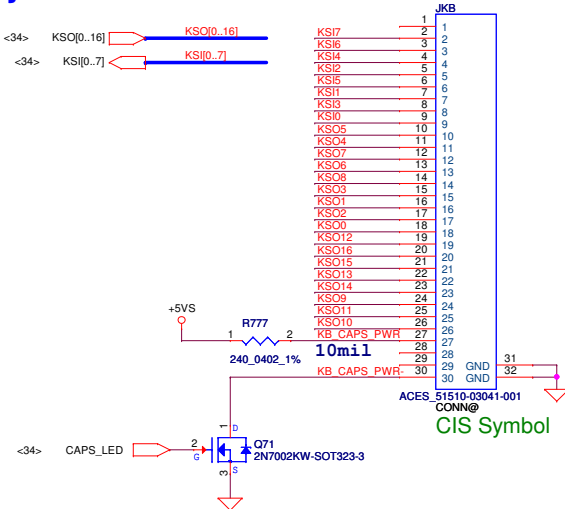
## FAN Control circuit



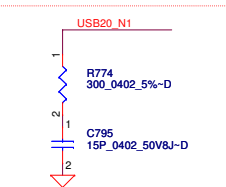
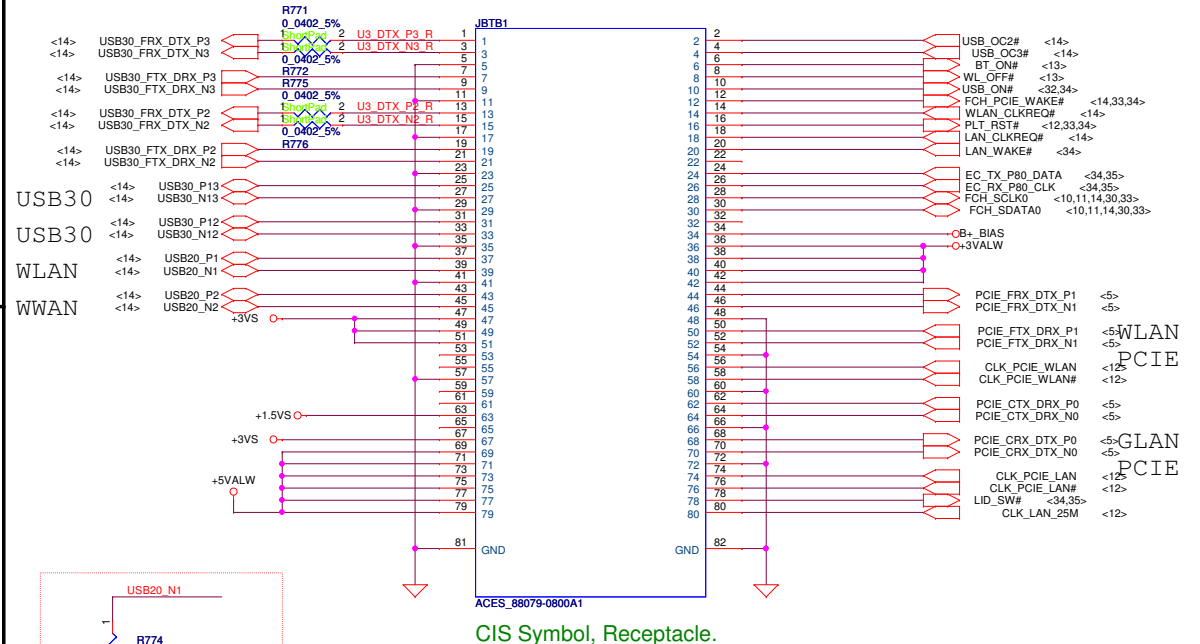
## Keyboard back light



## Keyboard Connector

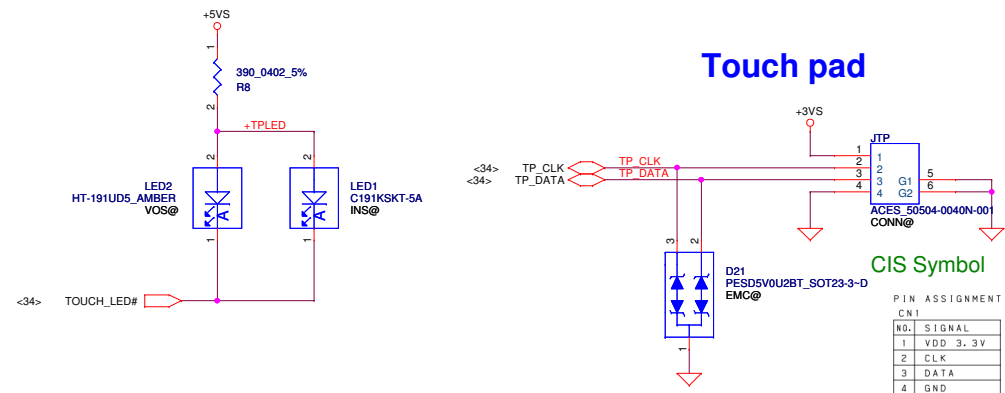


## M/B to D/B BTB connector, LAN, FMC, HMC, USB3.0\*2



AMD request 5/16

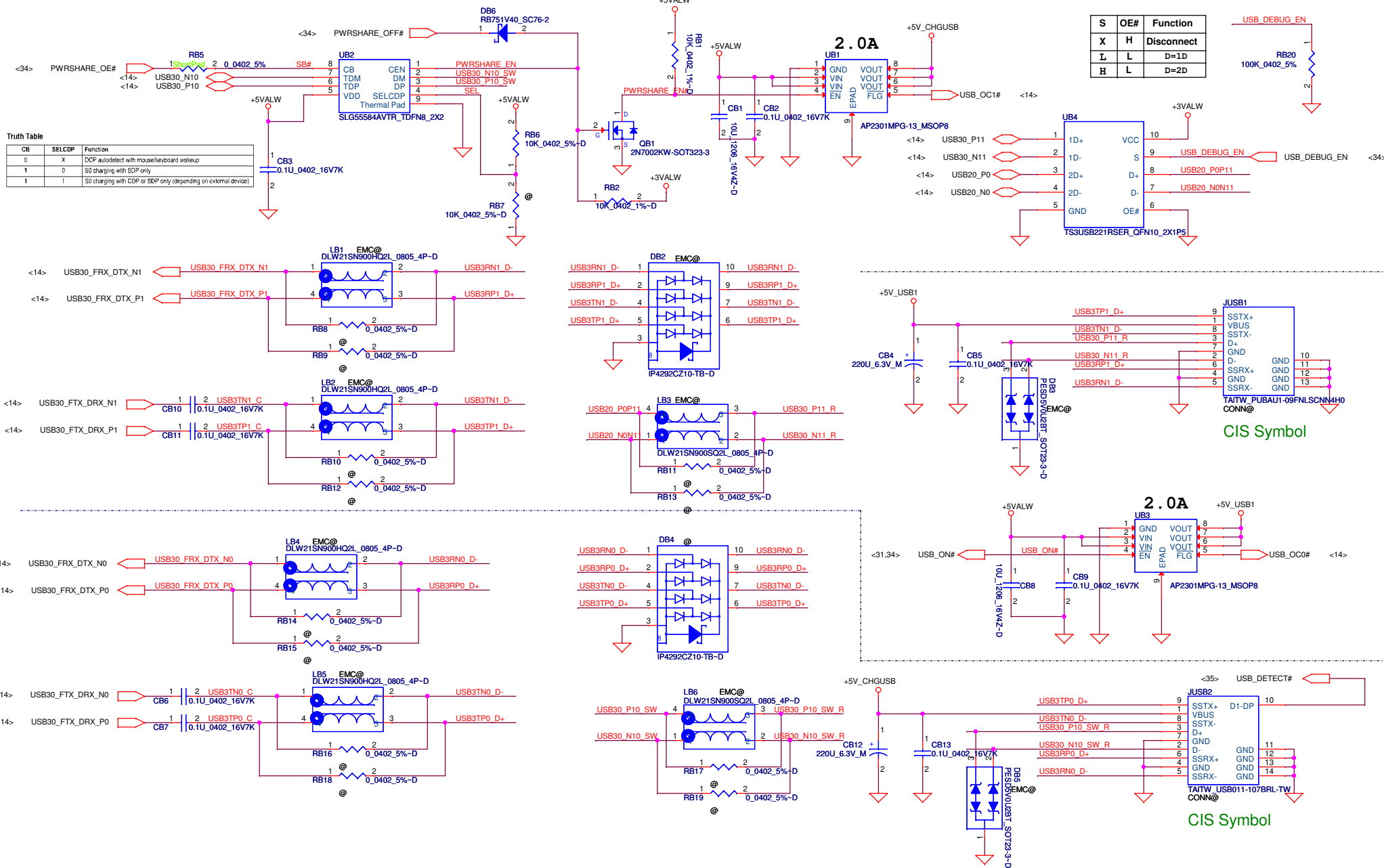
## Touch pad



Security Classification			Compal Secret Data		Title	
Issued Date	2011/08/01	Deciphered Date	2013/01/01		IO brd Conn & FAN/KB/TP	Rev 1.0
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.						
Date: Monday, July 16, 2012			Sheet 31 of 50			

# Power share

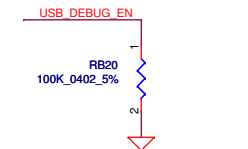
CB	Function
L	auto detection charger identification active
H	DP/DM=TDF/TDM



Truth Table

CB	SELCDP	Function
0	X	DCP autodetect with mouse/keyboard wakeup
1	0	SD charging with SDP only
1	1	SD charging with CDP or SDP only (depending on external device)

S	OE#	Function
X	H	Disconnect
L	L	D=1D
H	L	D=2D



CIS Symbol

CIS Symbol

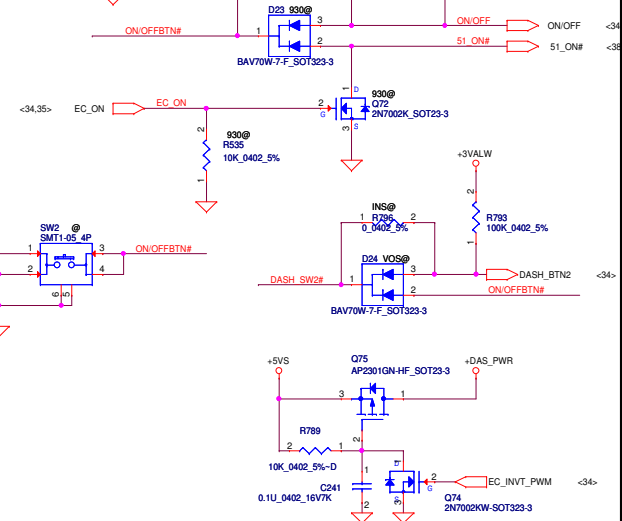
Security Classification		Compal Secret Data		Compal Electronics, Inc.	
Issued Date	2011/08/01	Deciphered Date	2013/01/01	Title	
				USB LP1/2	
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Size	Rev
				Customer	1.0
				Date	Monday, July 16, 2012
				Sheet	32 of 50

## ON/OFF switch

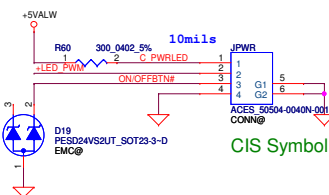
### Power Button

#### TOP Side

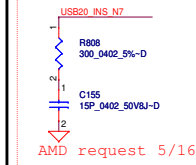
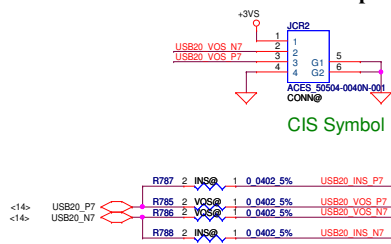
#### Bottom Side



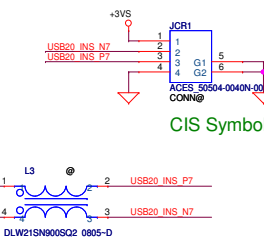
## Power Button Board Conn. 4pin



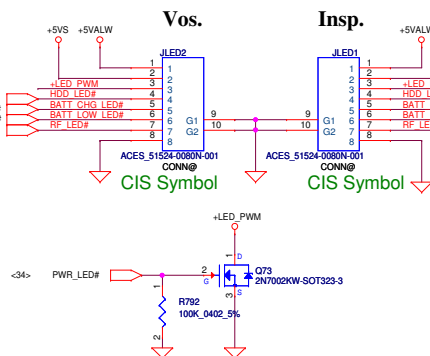
## Card Reader Conn For VOS. 4pin



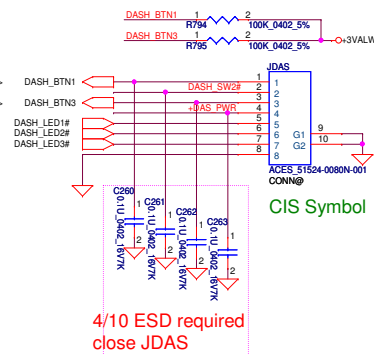
## Card Reader Conn For INS.



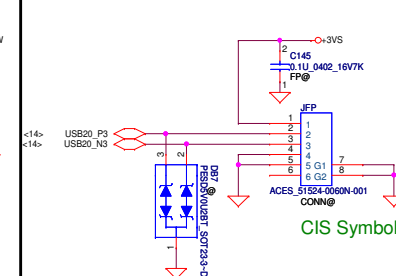
## LED Board Conn, include LID SW. 10pin



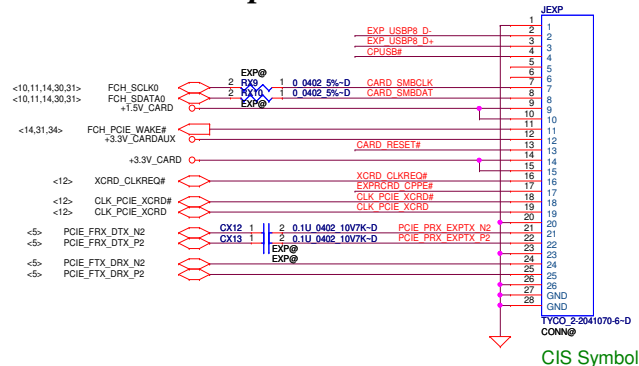
## Dashboard Function Conn. 8pin



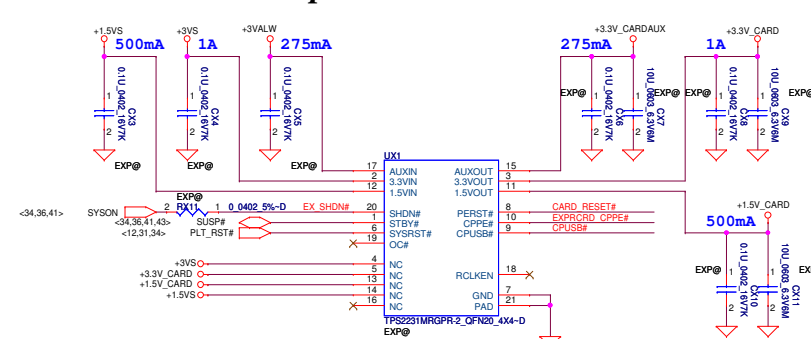
## Finger Printer Conn. 6pin



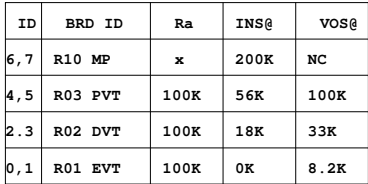
## Express Card



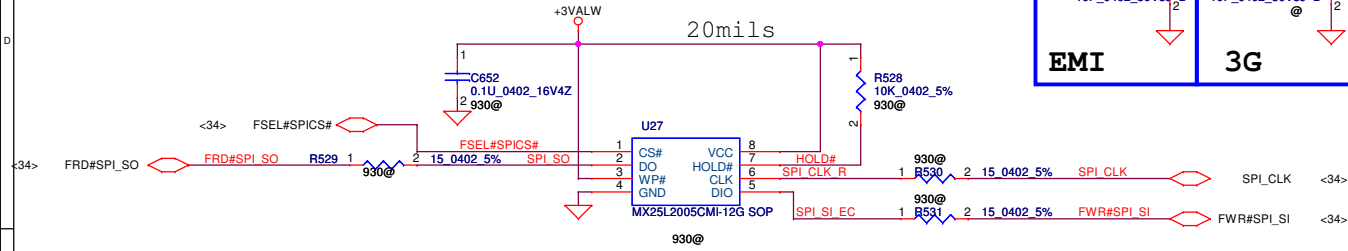
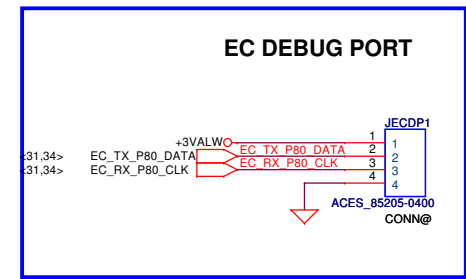
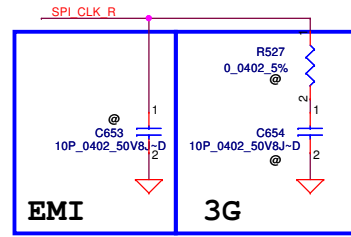
## Express Card PWR S/W



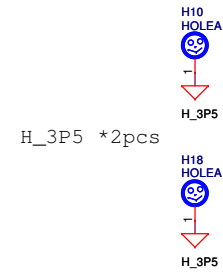
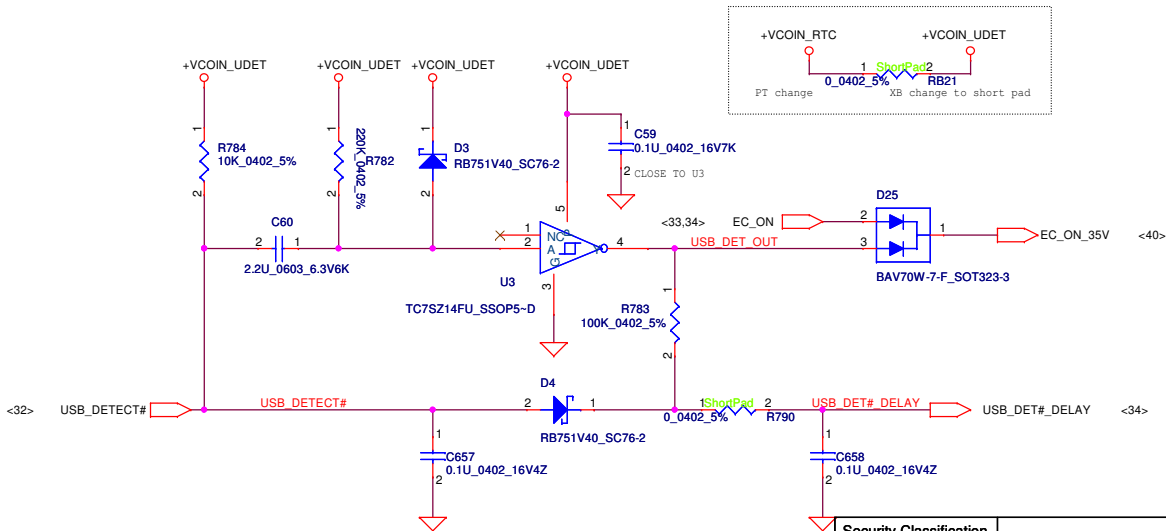
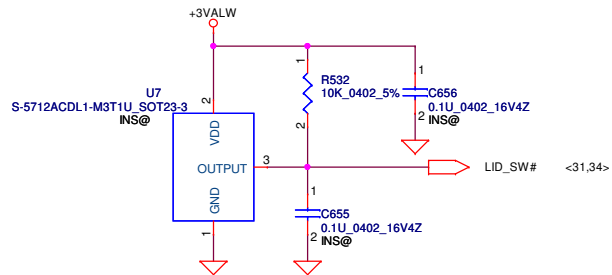
Security Classification		Compal Secret Data		Compal Electronics, Inc.	
Issued Date	2011/08/01	Deciphered Date	2013/01/01	Title	Other IO Conn. ExCARD
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Size	Document Number
				LA8251P	
Date: Monday, July 16, 2012		Sheet		33	of 50



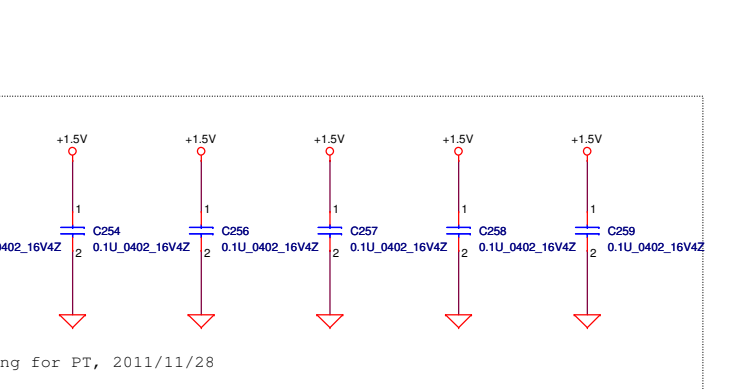
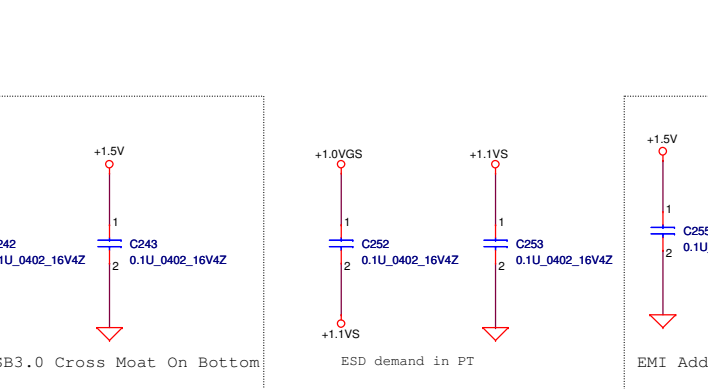
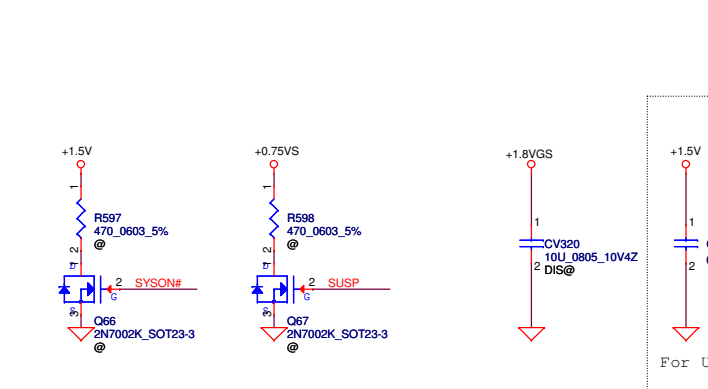
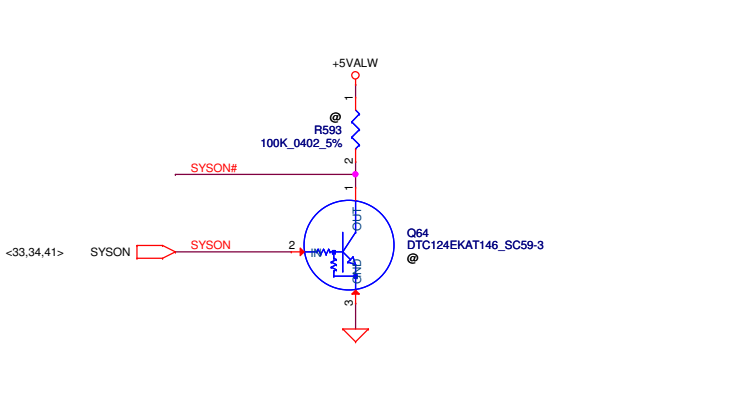
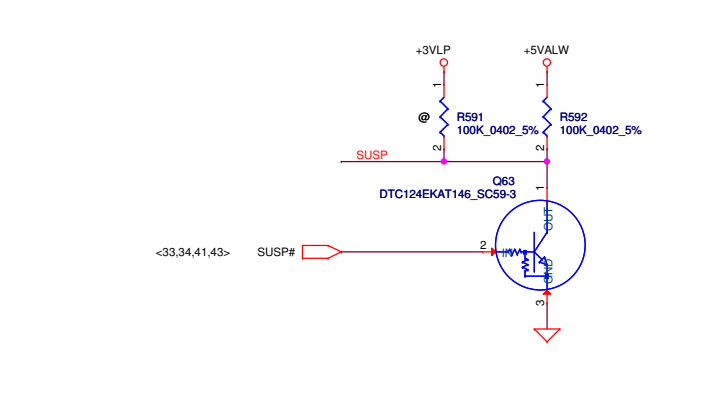
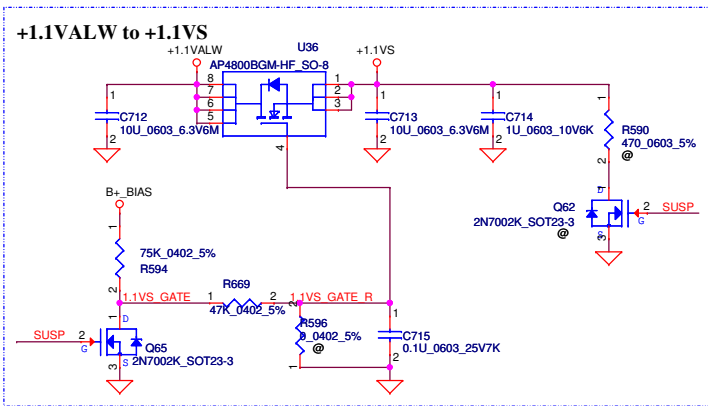
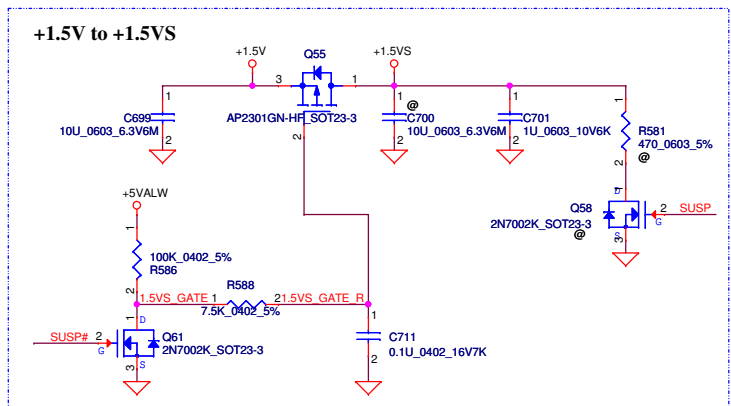
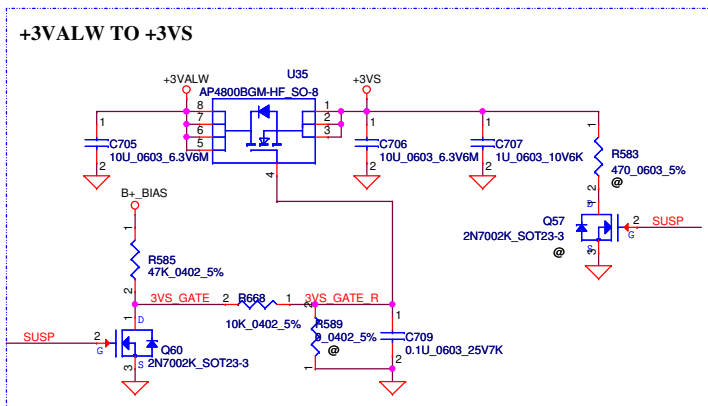
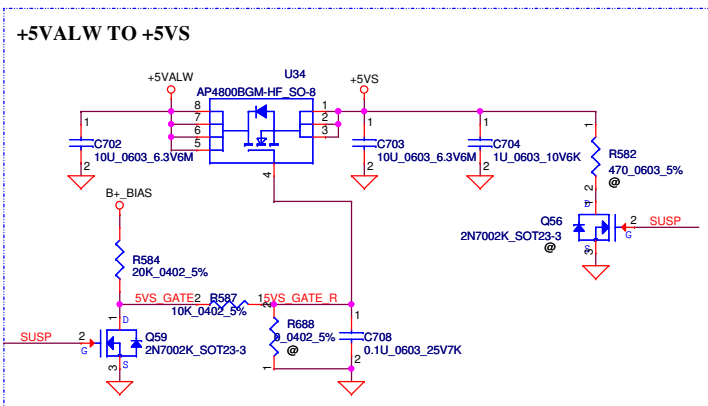
**FOR EC 128KB SPI ROM  
(150mil PACKAGE)  
SA00003FL10  
SA00003JD00**



## LID SWITCH FOR INS. ONLY



Security Classification		Compal Secret Data		<b>Compal Electronics, Inc.</b>			
Issued Date	2011/08/01	Deciphered Date	2013/01/01	Title EC ROM/Debug			
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Size	Document Number	Rev	
				B	LA8251P	1.0	
				Date:	Monday, July 16, 2012	Sheet 35 of 50	

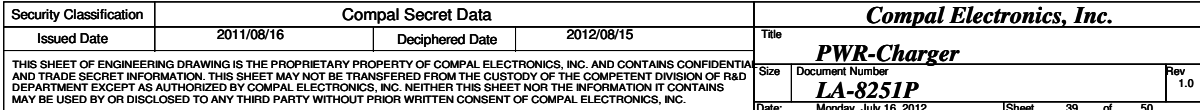


Security Classification		Compal Secret Data		Compal Electronics, Inc.	
Issued Date	2011/08/01	Deciphered Date	2013/01/01	Title	
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Document Number	Rev
				LA8251P	1.0
Date: Monday, July 16, 2012				Sheet	36 of 50





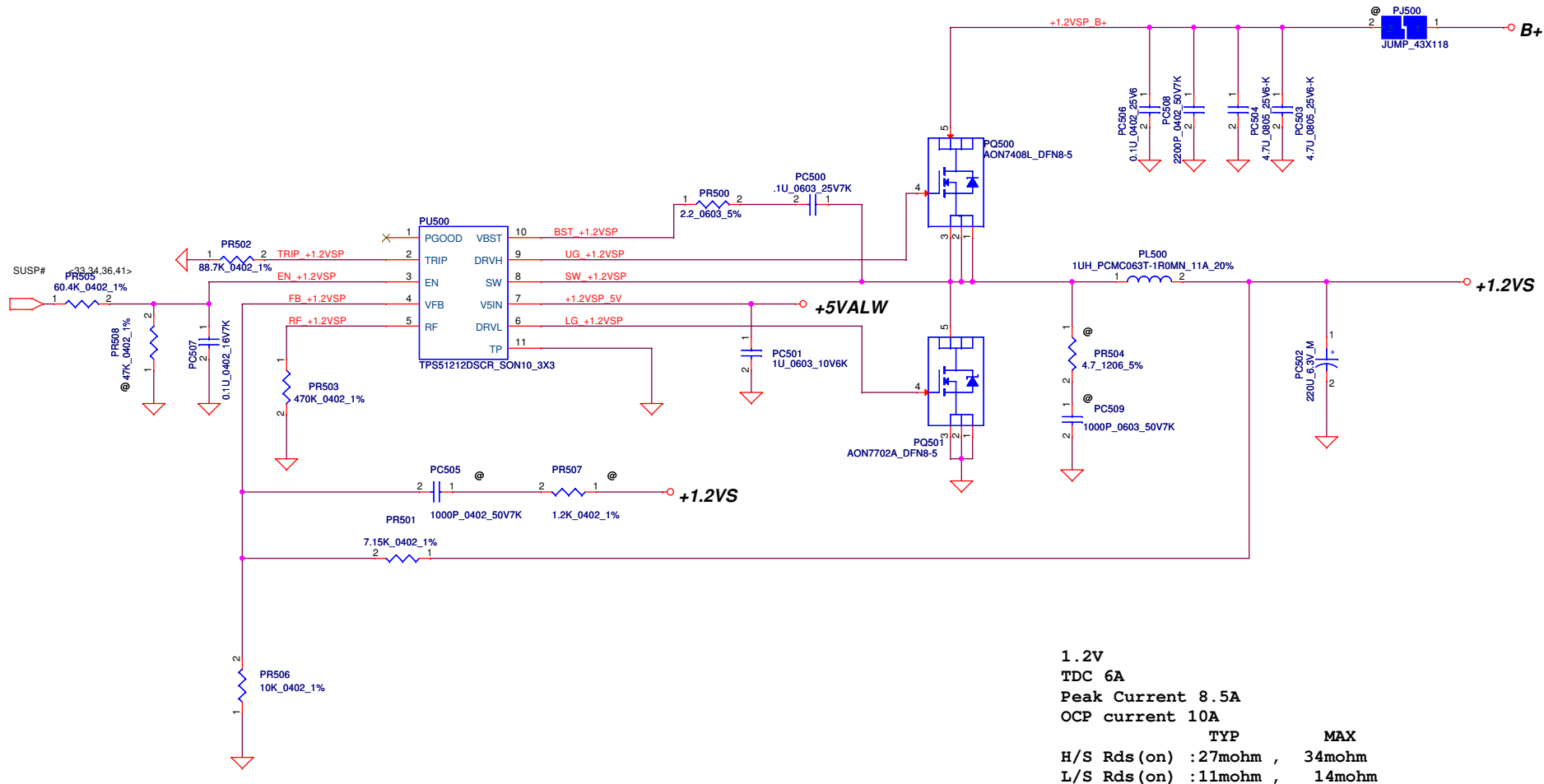




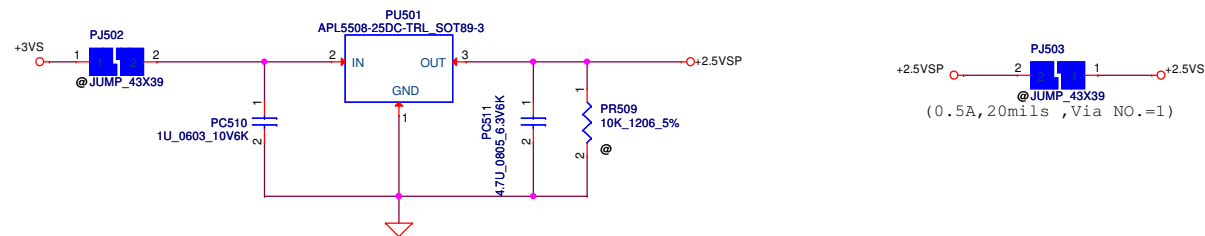






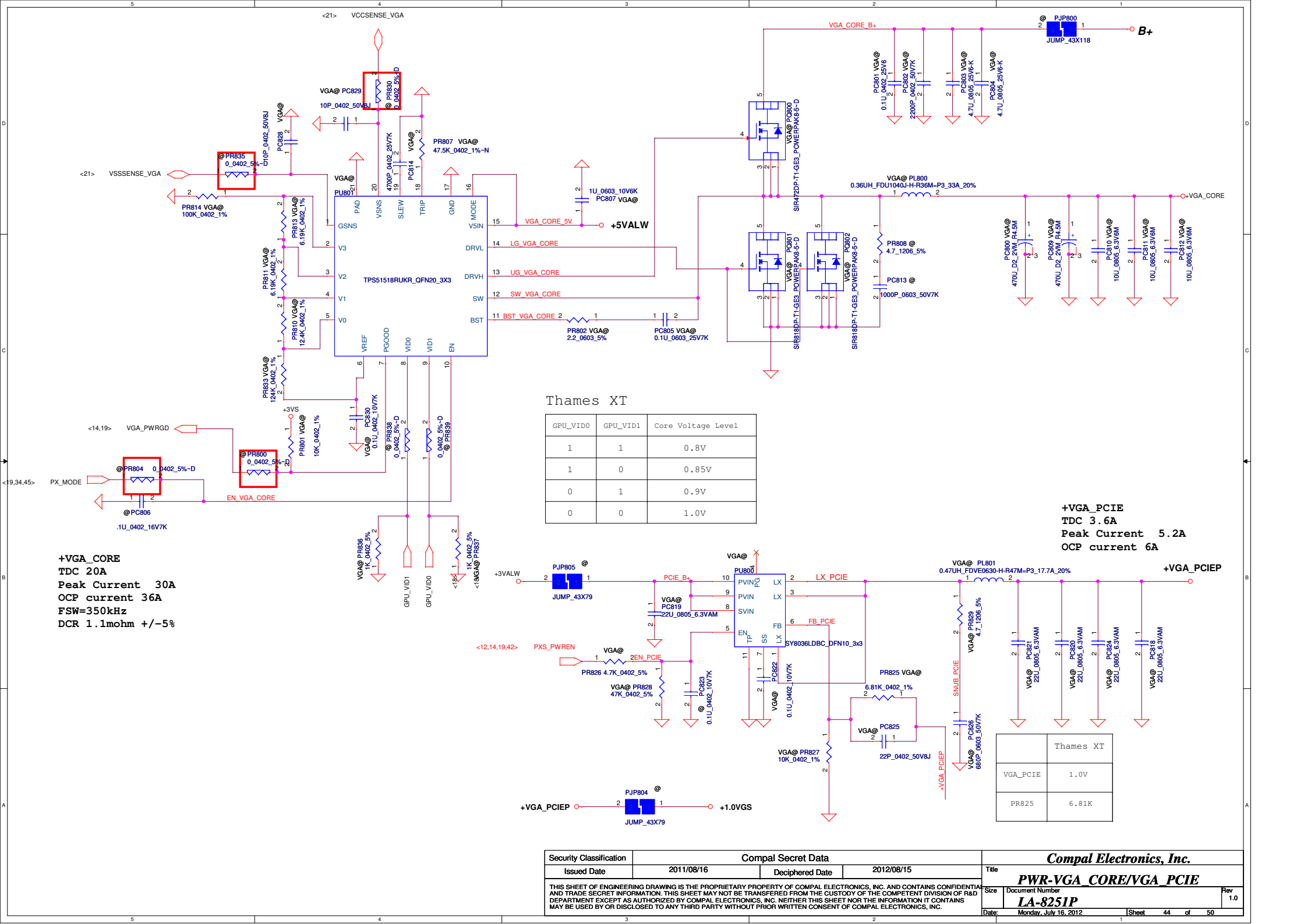


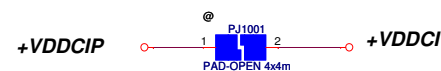
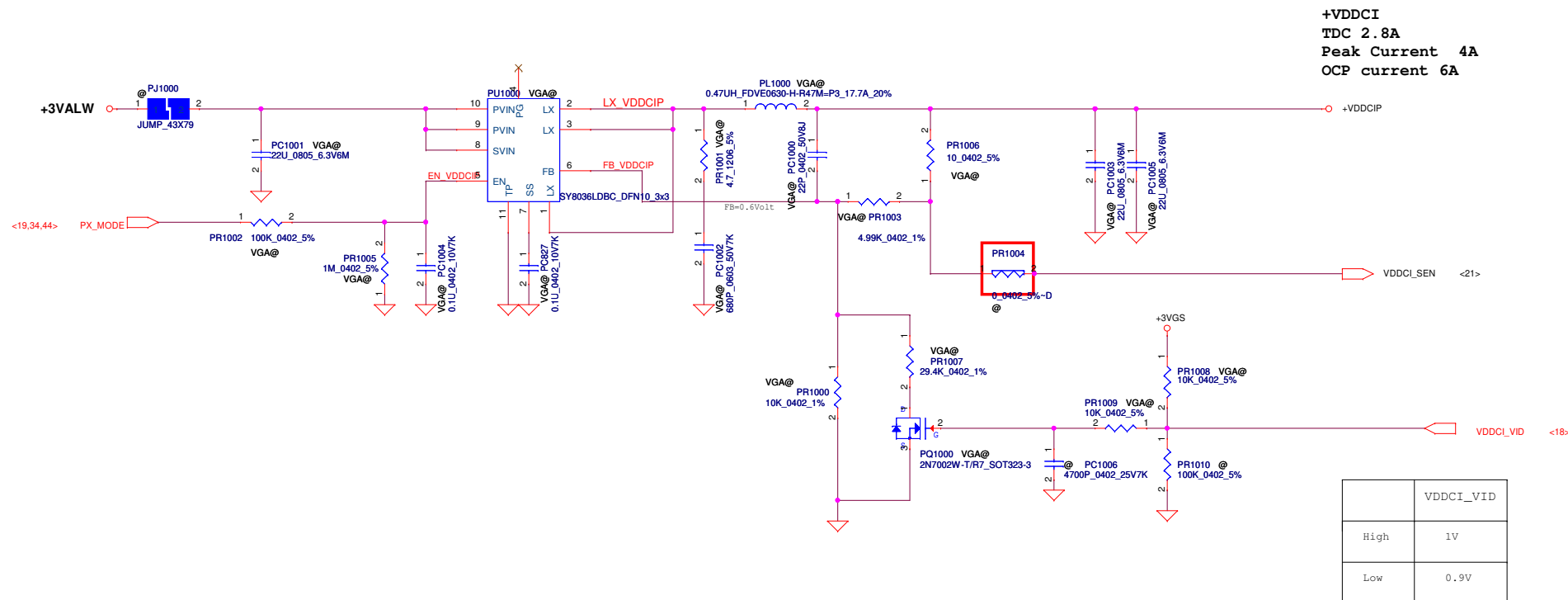
1.2V  
 TDC 6A  
 Peak Current 8.5A  
 OCP current 10A  
 TYP MAX  
 H/S Rds (on) :27mohm , 34mohm  
 L/S Rds (on) :11mohm , 14mohm

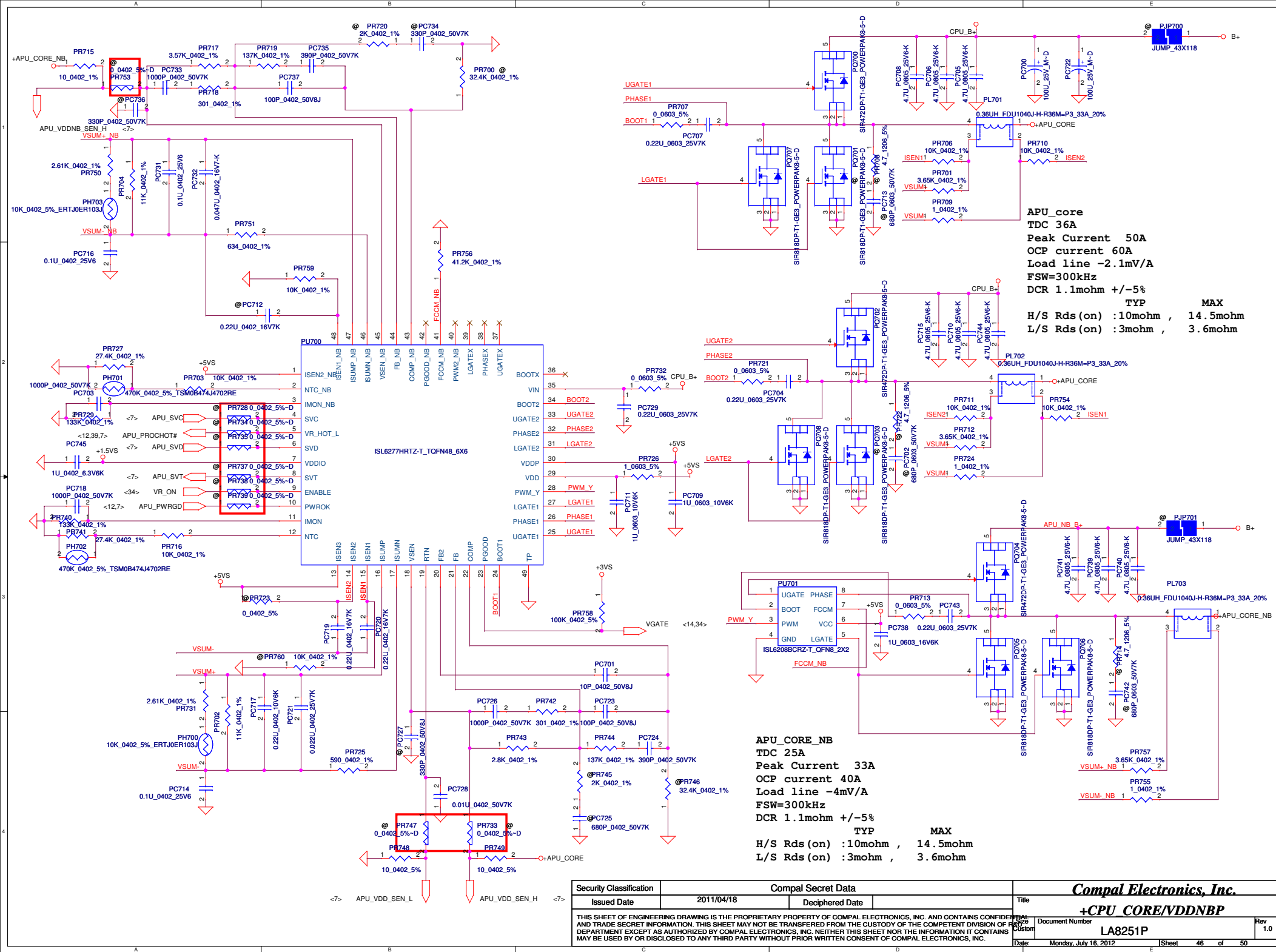


Security Classification		Compal Secret Data		Compal Electronics, Inc.	
Issued Date	2011/08/04	Deciphered Date	2012/08/03	Title	PWR-1.2VSP/2.5VSP
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Size	Document Number
				Date	Monday, July 16, 2012
				Sheet	43 of 50
				Rev	1.0

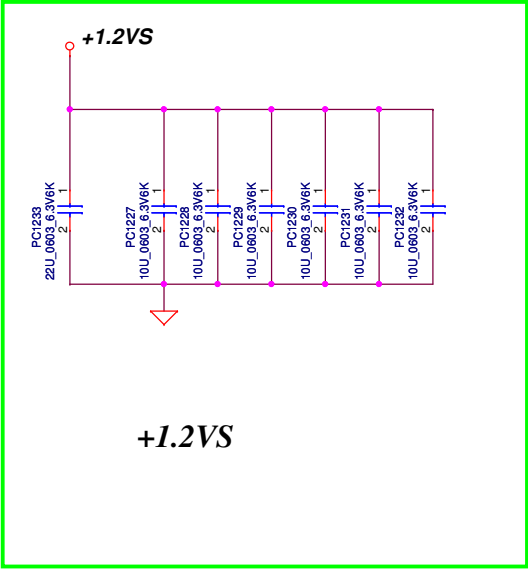
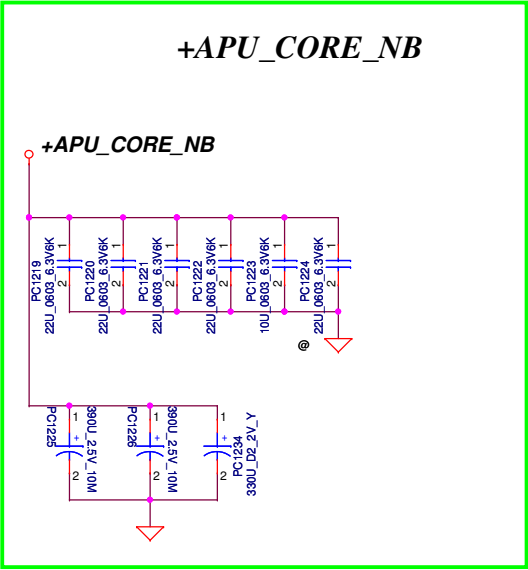
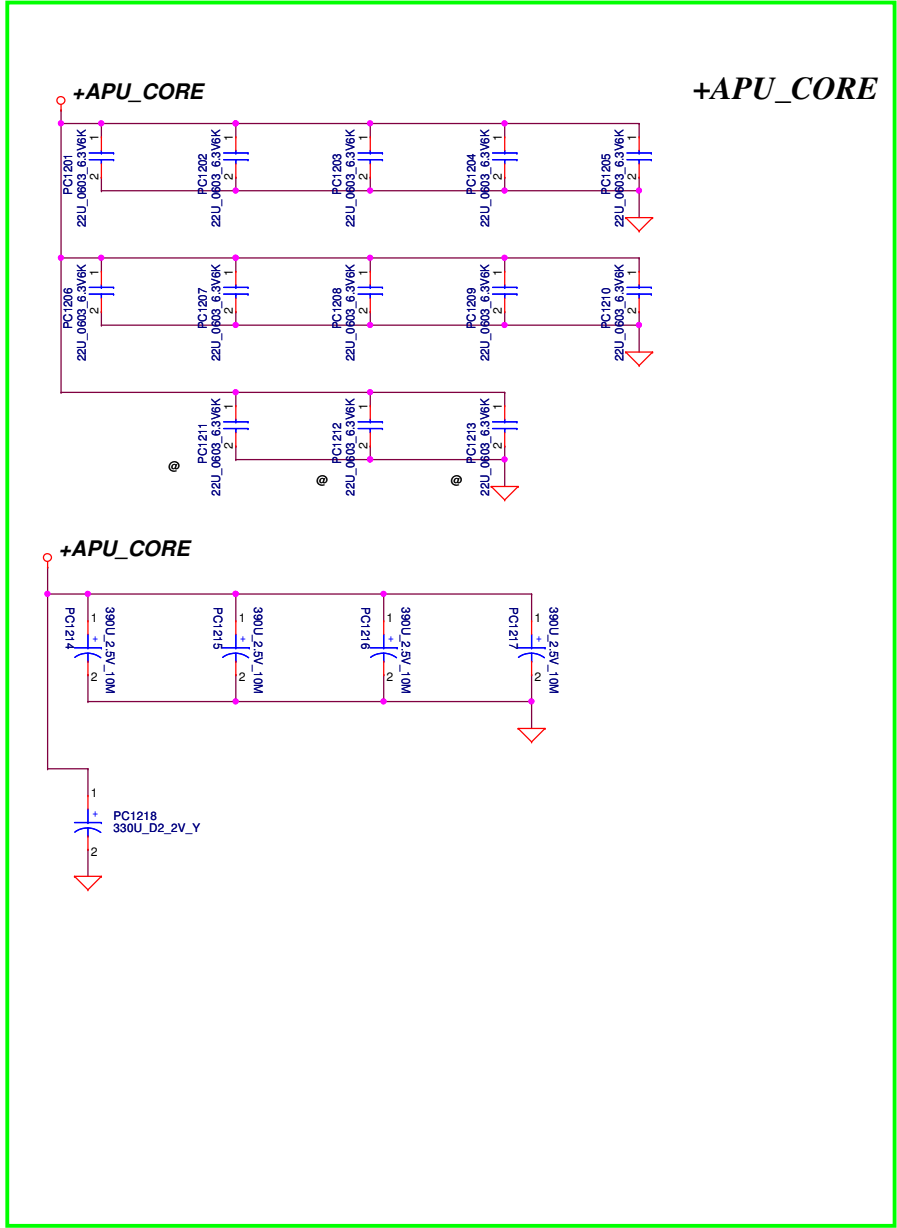






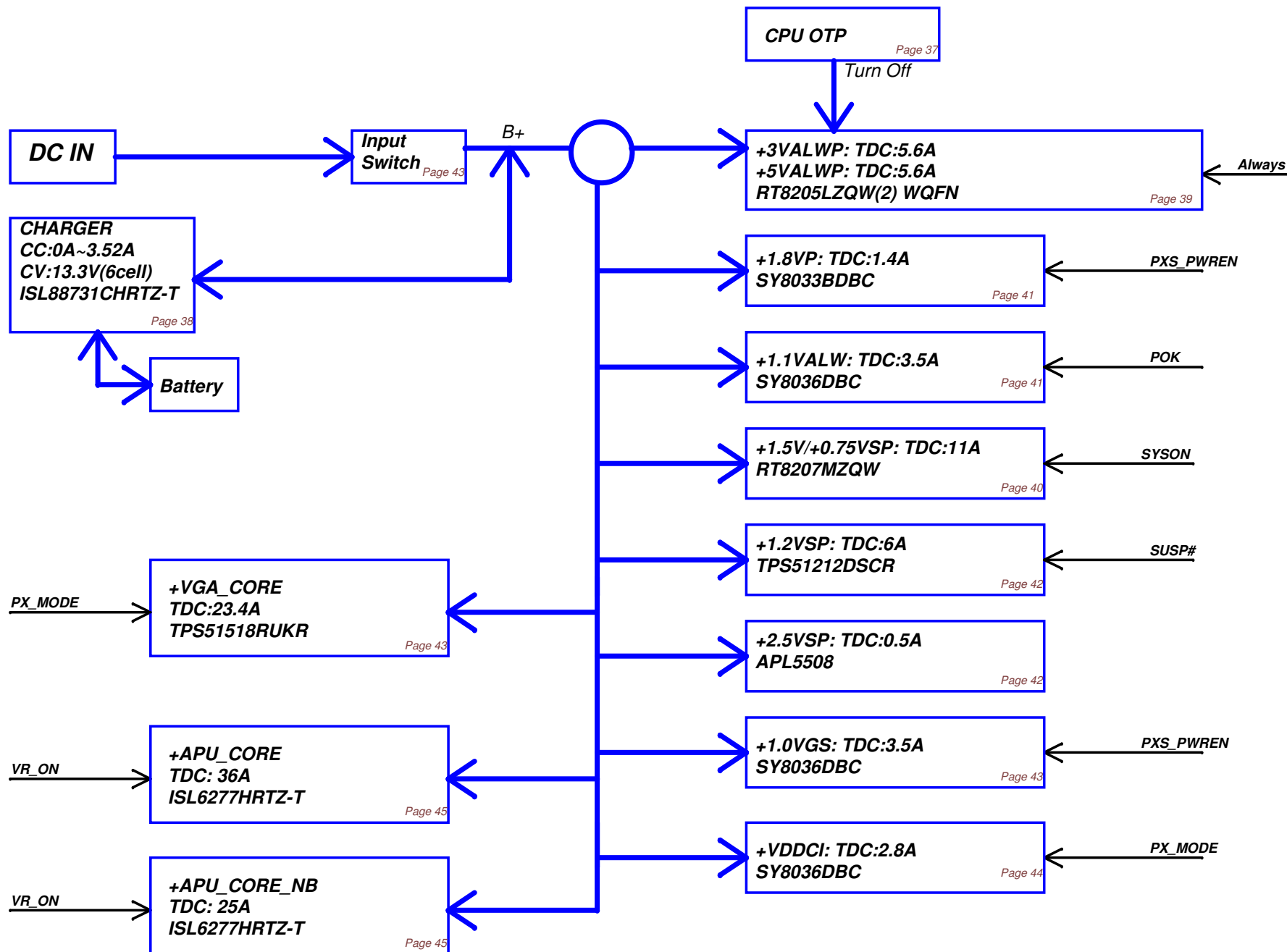


Security Classification		Compal Secret Data		<b>Compal Electronics, Inc.</b>		
Issued Date	2011/04/18	Deciphered Date		Title	<b>+CPU CORE/VDDNBP</b>	
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Document Number	Rev	
				Customer	LA8251P	1.0
C		D		Date:	Monday, July 16, 2012	
				Sheet	46	of 50



Security Classification		Compal Secret Data		Title	
Issued Date		Deciphered Date		Document Number	
2011/04/18				LA8251P	
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.		Date:		Monday, July 16, 2012	
				Sheet 47 of 50	

# Power block





## Version Change List (P. I. R. List)

## Page 1

Item	Page#	Title	Date	Request Owner	Issue Description	Solution Description	Rev.
1	9	XXXX	XX*XX/XX	Compal_XX	XXXXXX	Change PXXXX from Xohm to XXXKohm.	X01

Design Change				
Date	Page	Part reference	change description	Reason
10/17/2011	33	JLED2	Add JLED2 for Inspiron use only.	ME change drawing.
10/17/2011	30	UD1	Swap nets FCH_SDATA0/FCH_SCLK0	correct connection
10/17/2011	25	LV27.1	ADD RV327 for HPD	Vendor review
10/17/2011	25	RV268	DEL RV268	No need 1.2V from system.
10/17/2011	14	D6.D7	Change D6, D7 to Schottky for VGA PWR control	Original Diode, Vf too high.
10/17/2011	12	C159,C158	Change C159,C158 to 10pF	Vendor review
10/17/2011	12	D5,D8	Change D5, D8 to Schottky	Original Diode, Vf too high. Vendor review.
10/17/2011	27	DV8	Reserve DV8, use RV40 short.	HDMI Voltage issue.
10/17/2011	26	JLVDS	JLVDS Reverse Pin	LVDS connector location change.
10/17/2011	21	RV215	RV215 connect to net:+VDDCI	FB_VDDCI Should connect to +VDDCI
10/17/2011	37	AMP	Add an Audio AMP Circuit in page37	customer requires.
10/19/2011	33	DB7	Reserve DB7 for ESD	ESD request
10/19/2011	35	RB21	Adding RB21, change USB charge circuit power rail to +VCC	USB charge sequence fine tune
10/19/2011	34	U26	Dashboard button change to U26 pin34,36,75	to meet customer spec.
10/19/2011	13	U2	KB_DET# Change to FCH GPIO56, add Q76	EC pin saving.
10/20/2011	34	R503	DEL R503	Leakage form 3VALW to VS
10/20/2011	30	QD4	Add QD4	Leakage form 3VALW to VS
10/21/2011	33	R793,R794,R795,R796,D24	add R793,R794,R795 100K*3,R796 0ohm,D24 BAT54C	For Dashboard support 3 second boot up.
10/21/2011	37	U6	Reserve U6, C244~C251, R797~R799	Reserve GreenCLK
10/21/2011	31	JBTB1	change pin67 to +3VS, pin36,38,40,42 to +3VALW	LAN D/B design changes.
10/21/2011	27,32	JUSB2,JHDMI	update JUSB2 Footprint, JHDMI Footprint	ME change drawing.
10/25/2011	29	CA19,CA20	From 2.2uF to 4.7uF	Vendor review
10/25/2011	28	CV6, CV7, CV8	From 22pF to 10pF	CRT high resolution issue.
10/26/2011	33	R60,R8	Change to 300ohm	LED current need >5mA
10/26/2011	33	R792	Add 100Kohm to GND	Power LED issue.
10/26/2011	33	UX1	SYSON connect to UX1,20	Express Card not support S5 weakup.
10/28/2011	29	RA12,RA13	Change from 5.1ohm to 39.2ohm	Vendor review
11/21/2011	33	UX1	Connect pin1 to +3VS, pin14 to +1.5VS for 2nd GMT	2nd source required.
11/28/2011	7	Q6	Add Q6, Del Q1	ProcHot# change to High active. Common code for EC
11/28/2011	12	R109	10M reserved	Without RTC battery, system should not boot up issue
11/28/2011	36	EMI	Add C254,C255,C256,C257,C258,C259 0.1uF +1.5V	For EMI request
11/28/2011	32	UB4	AMD USB debug Port0 change to JUSB1	JUSB1 USB SI too margin. Due to switch serial resistor approx 10ohm

Design Change for PT				
Date	Page	Part reference	change description	Reason
04/03/12	18	YV1	27MHz package change to small size	Sourcer's recommend for cost down
04/03/12	26	JLVDS	pin assignment change for 31,32,33,34,35,37	Sourcer's recommend for cost down
04/03/12	35	C657	add 0.1u_0402 on USB_DETECT#	ESD required
04/03/12	35	C658	add 0.1u_0402 on USB_DET#_DELAY	ESD required
04/03/12	18	RV205,RV206	add 10K_0402 reserved only.	AMD Chelsea required
04/03/12	18	R804,R805	add 0_0402 reserved only.	AMD Chelsea required
04/03/12	20	RV244,CV366,RV208	add 2K_0402,10P_0402,0_0402, reserved	AMD Chelsea required
04/03/12	21	RV247,RV248	add 0_0402 reserved, RV247 stuffed.	AMD Chelsea required
04/03/12	18	RV250	add 0_0402 to GND for Thames, stuffed.	AMD Chelsea required
04/03/12	28	JCRT	footprint changed	DFB required
04/03/12	30	JHDD	footprint changed	DFB required
04/03/12	12	C158,C159,Y1	18p,18p,small size, 10P→18P	Sourcer's recommend for cost down
04/03/12	12	C155,C157,X1	12p,12p,small size, 27P→12P	Sourcer's recommend for cost down
04/12/12	19	RV104,RV101,QV21,CV96,RV103,RV109,QV25,RV99,RV100,QV18,QV19,QV20	Remove from BOM	These parts are PX4.0 supports. We support PX5.0 only.
04/12/12	19	RV112,RV113	RV113 Change 150K→240K, RV112 change 20K→240K.	Power rail +1.5VGS Timing fine tune.
04/12/12	18	R807,R806	Reserve 0ohm, R807 stuffed.	Reserve adaptor choice for dGPU GPIO5(net:AC_BATT)
04/12/12	29	R14,Q78	R14 10K, Q78 NMOS dual.	AMD recommend.
04/12/12	32	LB6, RB17, RB19	LB6 add to BOM.	EMI required.
04/12/12	13	R136	100K ohm stuffed.	Add PU for FCH GPIO171. (net:ODD_EN#)
04/12/12	14	R104	Reserve 0ohm.	Reserve for ODD_DA#
04/12/12	33	C260, C261, C262, C263	0.1uF stuffed.	ESD required
04/10/12	8	C100	Change to SGA00002280	ME Height limit. 4mm.
04/11/12	27	CV365,CV367	add 0.1U_0402_10V7K~D, reserve only.	EMI required, add caps in HDMI DDC
04/12/12	33	L3	add DLW21SN900SQ2_0805~D, reserve only.	EMI required, add CC in Cardreader
05/02/12	7	C71	pop 0.1U_0402_16V4Z	EE required, Shutdown issue, Leason learn from CGs

Design Change for ST				
Date	Page	Part reference	change description	Reason
05/31/12	26,33,33	RV328,R808,R774	add 300_0402_5%~D	AMD required, USB20 D- add RC for device lose
05/31/12	26,33,33	CV368,C155,C795	add 15P_0402_50V8J~D	AMD required, USB20 D- add RC for device lose
05/31/12	18,28	RV220,RV223,RV217,RV226,RV222,RV225,RV221,RV224,RV216,RV227,RV218,RV228,RV219,RV229	delete CRT debug	AMD required, for VGA layout concern.
05/31/12	7	Q6	reverse Q6	EE required
05/31/12	27	RV329,RV330	add 0_0603_5%~D	EMI required, DDC EMI issue.
05/31/12	27	D20	add PESD24VS2UT_SOT23-3~D, reserve only.	ESD required, HDMI plug issue, Leason learn from CGs
06/22/12	18	R806	pop R806 0ohm	Fast Power reduce function
06/23/12	27	RV39, RV41, RV42, RV44, RV53, RV54, RV57, RV58	Remove these part	change to common mode chock
06/24/12	27	LV4, LV5, LV6, LV7	add these KINGCORE WCM-2012HS-900T common mode chock	EMI required for HDMI noise
06/25/12	27	CV351, CV352, CV349, CV350, CV353, CV354, CV355, CV356	add these 3.3pF 50V 0402	EMI required for HDMI noise
06/26/12	27	CV364, CV363, CV360, CV361, CV358, CV357, CV362, CV359	add these 1pF 50V 0402	EMI required for HDMI noise
06/22/12	32	DB4	Remove	USB detect issue

Security Classification		Compal Secret Data		Title	
Issued Date	2011/04/18	Deciphered Date		HW-PIR	
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Size Custom	Document Number LA8251P
				Date: Monday, July 16, 2012	Sheet 80 of 80